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LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV
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LMx24, LMx24x, LMx24xx, LM2902, LM2902x, LM2902xx, LM2902xxx Quadruple Operational Amplifiers

1 Features

- Next-generation LM324B and LM2902B
- B versions are drop-in replacements for all versions of LM224, LM324, and LM2902
- Improved specifications of B version
  - Supply range: 3V to 36V (B, BA versions)
  - Low input offset voltage: ±2mV (BA version) / 3mV (B version)
  - ESD rating: 2kV (HBM), 1.5kV (CDM)
  - EMI rejection: integrated RF and EMI filter
  - Low input bias current: 50nA maximum (across −40°C to 125°C)
- Common-mode input voltage range includes V−
- Input voltage differential can be driven up to supply voltage
- For dual B versions, see LM358B and LM2904B

2 Applications

- Merchant network and server power supply units
- Multi-function printers
- Power supplies and mobile chargers
- Desktop PC and motherboard
- Indoor and outdoor air conditioners
- Washers, dryers, and refrigerators
- AC inverters, string inverters, central inverters, and voltage frequency drives
- Uninterruptible power supplies

3 Description

The LM324B and LM2902B devices are the next-generation versions of the industry-standard operational amplifiers (op amps) LM324 and LM2902, which include four high-voltage (36V) op amps. These devices provide outstanding value for cost-sensitive applications,

with features including low offset (600µV, typical), common-mode input range to ground, and high differential input voltage capability.

The LM324B and LM2902B are unity-gain stable and achieve a low offset voltage maximum of 3mV (2mV maximum for LM324BA and LM2902BA) and quiescent current of 240µA per amplifier (typical). High ESD (2kV HBM and 1.5kV CDM) and integrated EMI and RF filters enable the LM324B and LM2902B devices to be used in the most rugged, environmentally challenging applications.

The LM324B and LM2902B can drop-in replace all versions of the LM224, LM324, and LM2902 devices.

Package Information

PART NUMBER[1]	PACKAGE	PACKAGE SIZE[2]
LM324B, LM324BA, LM2902B, LM2902BA, LM324xx, LM224xx, LM124, LM2902xxx	D (SOIC, 14)	8.65mm × 6mm
LM324B, LM324BA, LM2902B, LM2902BA, LM324xx, LM124, LM2902xxx	PW (TSSOP, 14)	5mm × 6.4mm
LM324xx, LM224xx, LM2902xxx	N (PDIP, 14)	19.3mm × 9.4mm
LM324, LM324A, LM324K, LM324KA, LM2902, LM2902K	NS (SOP, 14)	10.3mm × 7.8mm
LM324A, LM2902K	DB (SSOP, 14)	6.2mm × 7.8mm
LM124A	J (CDIP, 14)	19.56mm × 6.67mm
LM124A	W (CFP, 14)	9.21mm × 6.3mm
LM124A	FK (LCCC, 20)	8.89mm × 8.89mm
LM324B, LM2902B	RTE (WQFN, 16[3])	3mm × 3mm

(1) For more information, see Section 11.
(2) The package size (length × width) is a nominal value and includes pins, where applicable.
(3) This package is preview only.

Family Comparison

SPECIFICATION	LM324B LM324BA	LM2902B LM2902BA	LM324 LM324A	LM324K LM324KA	LM2902	LM2902K LM2902KV LM2902KAV	LM224 LM224A	LM224K LM224KA	LM124 LM124A	Units
Supply voltage	3 to 36	3 to 36	3 to 30	3 to 30	3 to 26	3 to 26 (K) 3 to 30 (KV, KAV)	3 to 30	3 to 30	3 to 30	V
Offset voltage (max, 25°C)	± 3 ± 2	± 3 ± 2	± 7 ± 3	± 7 ± 3	± 7	± 7 (K, KV) ± 2 (KAV)	± 5 ± 3	± 5 ± 3	± 5 ± 2	mV
Input bias current at 25 °C (typ / max)	10 / 35	10 / 35	20 / 250 15 / 100	20 / 250 15 / 100	20 / 250	20 / 250	20 / 150 15 / 80	20 / 150 15 / 80	20 / 150 – / 50	nA
ESD (HBM)	2000	2000	500	2000	500	2000	500	2000	500	V
Operating ambient temperature	−40 to 85	−40 to 125	0 to 70	0 to 70	−40 to 125	−40 to 125	−25 to 85	−25 to 85	−55 to 125	°C

LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV
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Product Folder Links: *LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902 LM2902B LM2902BA LM2902K LM2902KV LM2902KAV*

LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV

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4 Pin Configuration and Functions

**Figure 4-1. D, DB, J, N, NS, PW, and W Packages,
14-Pin SOIC, SSOP, CDIP, PDIP, SO, TSSOP, and
CFP
(Top View)**

**Figure 4-2. FK Package,
20-Pin LCCC
(Top View)**

NOTE: RTE package is preview only

**Figure 4-3. RTE Package,
16-Pin WQFN
(Top View)**

Table 4-1. Pin Functions

PIN				TYPE[1]	DESCRIPTION
NAME	LCCC	SOIC, TSSOP, PDIP, SSOP, SO, CDIP, and CFP	WQFN		
1IN–	3	2	16	I	Negative input
1IN+	4	3	1	I	Positive input
1OUT	2	1	15	O	Output
2IN–	9	6	5	I	Negative input
2IN+	8	5	4	I	Positive input

Product Folder Links: *LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902
LM2902B LM2902BA LM2902K LM2902KV LM2902KAV*

LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV

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Table 4-1. Pin Functions (continued)

PIN				TYPE[1]	DESCRIPTION
NAME	LCCC	SOIC, TSSOP, PDIP, SSOP, SO, CDIP, and CFP	WQFN		
2OUT	10	7	6	O	Output
3IN–	13	9	8	I	Negative input
3IN+	14	10	9	I	Positive input
3OUT	12	8	7	O	Output
4IN–	19	13	13	I	Negative input
4IN+	18	12	12	I	Positive input
4OUT	20	14	14	O	Output
V_{CC-}	16	11	11	—	Negative (lowest) supply or ground (for single-supply operation)
NC	1, 5, 7, 11, 15, 17	—	3, 10	—	Do not connect
V_{CC+}	6	4	2	—	Positive (highest) supply

(1)   I = input, O = output

**LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV**

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5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)[1]

		LM324B, LM324BA, LM2902B, LM2902BA		LM2902		LM324xx, LM224xx, LM2902xxx, LM124x		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
Supply voltage, V_{CC} [2]			40		26		32	V
Differential input voltage, V_{ID} [3]			±40		±26		±32	V
Input voltage, V_I (either input)		–0.3	40	–0.3	26	–0.3	32	V
Duration of output short circuit (one amplifier) to ground at (or below) T_A = 25°C, V_{CC} ≤ 15 V[4]		Unlimited		Unlimited		Unlimited		
Operating virtual junction temperature, T_J			150		150		150	°C
Case temperature for 60 seconds	FK package						260	°C
Lead temperature 1.6 mm (1/16 inch) from case for 60 seconds	J or W package				300		300	°C
Storage temperature, T_{stg}		–65	150	–65	150	–65	150	°C

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.
(3) Differential voltages are at IN+, with respect to IN−.
(4) Short circuits from outputs to VCC can cause excessive heating and eventual destruction.

5.2 ESD Ratings

			VALUE	UNIT
LM324B, LM324BA, LM2902B, LM2902BA, LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV				
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001[1]	±2000	V
		Charged-device model (CDM), per JEDEC specification JESD22-C101	±1000	
LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902				
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001[1]	±500	V
		Charged-device model (CDM), per JEDEC specification JESD22-C101	±1000	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		LM324B, LM324BA, LM2902B, LM2902BA		LM2902		LM324xx, LM224xx, LM2902xxx, LM124x		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
V_{CC} Supply voltage		3	36	3	26	3	30	V
V_{CM} Common-mode voltage		0	$V_{CC} - 2$	0	$V_{CC} - 2$	0	$V_{CC} - 2$	V
T_A Operating free air temperature	LM124x					–55	125	°C
	LM2902xxx, LM2902Bx	–40	125	–40	125			
	LM324Bx	–40	85					
	LM224xx					–25	85	
	LM324xx					0	70	

LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV

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5.4 Thermal Information

THERMAL METRIC[1]		LMx24, LM2902						LMx24			UNIT
		D (SOIC)	DB (SSOP)	N (PDIP)	NS (SO)	PW (TSSOP)	RTE (WQFN) [5]	FK (LCCC)	J (CDIP)	W (CFP)	
		14 PINS	14 PINS	14 PINS	14 PINS	14 PINS	16 PINS	20 PINS	14 PINS	14 PINS	
$R_{\theta JA}$ [2] [3]	Junction-to-ambient thermal resistance	99.3	106.5	83.5	90.4	124.7	64.9	74.5	84.7	153.4	°C/W
$R_{\theta JC(top)}$ [4]	Junction-to-case (top) thermal resistance	60.4	55.5	62.0	48.0	57.9	68.8	49.9	37.5	72.7	°C/W
$R_{\theta JB}$		57.5	56.8	57.7	49.2	80.7	40.2	49.0	72.2	146.5	
ψ_{JT}		19.8	18.2	40.5	14.4	8.4	4.9	42.9	31.0	48.3	
ψ_{JB}		57.0	55.8	57.1	48.8	79.8	40.0	48.9	67.3	129.2	
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	—	—	—	—	—	23.6	7.3	18.8	10.1	°C/W

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application note.
(2) Short circuits from outputs to VCC can cause excessive heating and eventual destruction.
(3) Maximum power dissipation is a function of $T_{J(max)}$, $R_{\theta JA}$, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_{J(max)} - T_A)/R_{\theta JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
(4) Maximum power dissipation is a function of $T_{J(max)}$, $R_{\theta JA}$, and T_C. The maximum allowable power dissipation at any allowable case temperature is $P_D = (T_{J(max)} - T_C)/R_{\theta JC}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
(5) This package is preview only.

Product Folder Links: *LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902 LM2902B LM2902BA LM2902K LM2902KV LM2902KAV*

5.5 Electrical Characteristics - LM324B and LM324BA

For V_S = (V+) – (V–) = 5 V to 36 V (±2.5 V to ±18 V), at T_A = 25°C, V_{CM} = V_{OUT} = V_S / 2, and R_L = 10 kΩ connected to V_S / 2 (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
OFFSET VOLTAGE								
V_{OS}	Input offset voltage	LM324B				±0.6	±3.0	mV
				T_A = –40°C to 85°C			±4.0	
		LM324BA				±0.3	±2	
				T_A = –40°C to 85°C			2.5	
dV_{OS}/dT	Input offset voltage drift	R_S = 0 Ω		T_A = –40°C to 85°C		±7		µV/°C
PSRR	Input offset voltage versus power supply				65	100		dB
	Channel separation	f = 1 kHz to 20 kHz				120		dB
INPUT VOLTAGE RANGE								
V_{CM}	Common-mode voltage range	V_S = 3 V to 36 V			V–		(V+) – 1.5	V
		V_S = 5 V to 36 V		T_A = –40°C to 85°C	V–		(V+) – 2	
CMRR	Common-mode rejection ratio	(V–) ≤ V_{CM} ≤ (V+) – 1.5 V	V_S = 3 V to 36 V		70	80		dB
		(V–) ≤ V_{CM} ≤ (V+) – 2 V	V_S = 5 V to 36 V	T_A = –40°C to 85°C	65	80		
INPUT BIAS CURRENT								
I_B	Input bias current					-10	-35	nA
				T_A = –40°C to 85°C			-60	
dI_{OS}/dT	Input offset current drift			T_A = –40°C to 85°C		10		pA/°C
I_{OS}	Input offset current					±0.5	±4	nA
				T_A = –40°C to 85°C			±5	
dI_{OS}/dT	Input offset current drift			T_A = –40°C to 85°C		10		pA/°C
NOISE								
E_N	Input voltage noise	f = 0.1 to 10 Hz				3		µV$_{PP}$
e_N	Input voltage noise density	R_S = 100 Ω, V_I = 0 V, f = 1 kHz (see Figure 7-2 for test circuit)				35		nV/√Hz
INPUT CAPACITANCE								
Z_{ID}	Differential					10 ‖ 0.1		MΩ ‖ pF
Z_{ICM}	Common-mode					4 ‖ 1.5		GΩ ‖ pF
OPEN-LOOP GAIN								
A_{OL}	Open-loop voltage gain	V_S = 15 V, V_O = 1 V to 11 V, R_L ≥ 10 kΩ, connected to (V-)			50	100		V/mV
				T_A = –40°C to 85°C	25			
FREQUENCY RESPONSE								
GBW	Gain-bandwidth product	R_L = 1 MΩ, C_L = 20 pF (see Figure 7-1 for test circuit)				1.2		MHz
SR	Slew rate	R_L = 1 MΩ, C_L = 30 pF, V_I = ±10 V (see Figure 7-1 for test circuit)				0.5		V/µs
Θ_m	Phase margin	G = + 1, R_L = 10kΩ, C_L = 20 pF				56		°
t_S	Settling time	To 0.1%, V_S = 5 V, 2-V Step , G = +1, C_L = 100 pF				4		µs
	Overload recovery time	V_{IN} × gain > V_S				10		µs
THD+N	Total harmonic distortion + noise	G = + 1, f = 1 kHz, V_O = 3.53 V_{RMS}, V_S = 36 V, R_L = 100 kΩ, I_{OUT} ≤ 50 µA, BW = 80 kHz				0.001%		
OUTPUT								
V_O	Voltage output swing from rail	Positive Rail (V+)		I_{OUT} = -50 µA		1.35	1.5	V
V_O				I_{OUT} = -1 mA		1.4	1.6	V
V_O				I_{OUT} = -5 mA		1.5	1.75	V
V_O		Negative Rail (V-)		I_{OUT} = 50 µA		100	150	mV
V_O				I_{OUT} = 1 mA		0.75	1	V
V_O			V_S = 5 V, RL ≤ 10 kΩ connected to (V–)	T_A = –40°C to 85°C		5	20	mV
I_O	Output current	V_S = 15 V; V_O = V-; V_{ID} = 1 V	Source		-20[1]	-30		mA
				T_A = –40°C to 85°C	-10[1]			mA
		V_S = 15 V; V_O = V+; V_{ID} = -1 V	Sink		10[1]	20		mA
				T_A = –40°C to 85°C	5[1]			mA
		V_{ID} = -1 V; V_O = (V-) + 200 mV			50	85		µA
I_{SC}	Short-circuit current	V_S = 20 V, (V+) = 10 V, (V-) = -10 V, V_O = 0 V				±40	±60	mA
C_{LOAD}	Capacitive load drive					100		pF

Product Folder Links: *LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902 LM2902B LM2902BA LM2902K LM2902KV LM2902KAV*

5.5 Electrical Characteristics - LM324B and LM324BA (continued)

For V_S = (V+) – (V–) = 5 V to 36 V (±2.5 V to ±18 V), at T_A = 25°C, V_{CM} = V_{OUT} = V_S / 2, and R_L = 10 kΩ connected to V_S / 2 (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
R_O	Open-loop output impedance	f = 1 MHz, I_O = 0 A			300		Ω
POWER SUPPLY							
I_Q	Quiescent current per amplifier	V_S = 5 V; I_O = 0 A	T_A = –40°C to 85°C		240	300	µA
		V_S = 36 V; I_O = 0 A	T_A = –40°C to 85°C		350	750	µA

(1) Specified by design and characterization only.

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LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV

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5.6 Electrical Characteristics - LM2902B and LM2902BA

For V_S = (V+) – (V–) = 5 V to 36 V (±2.5 V to ±18 V), at T_A = 25°C, V_{CM} = V_{OUT} = V_S / 2, and R_L = 10 kΩ connected to V_S / 2 (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
OFFSET VOLTAGE								
V_{OS}	Input offset voltage	LM2902B				±0.6	±3.0	mV
			T_A = –40°C to 125°C				±4.0	
		LM2902BA				±0.3	±2	
			T_A = –40°C to 125°C				2.5	
dV_{OS}/dT	Input offset voltage drift	R_S = 0 Ω	T_A = –40°C to 125°C			±7		µV/°C
PSRR	Input offset voltage versus power supply				65	100		dB
	Channel separation	f = 1 kHz to 20 kHz				120		dB
INPUT VOLTAGE RANGE								
V_{CM}	Common-mode voltage range	V_S = 3 V to 36 V			V–		(V+) – 1.5	V
		V_S = 5 V to 36 V		T_A = –40°C to 125°C	V–		(V+) – 2	
CMRR	Common-mode rejection ratio	(V–) ≤ V_{CM} ≤ (V+) – 1.5 V	V_S = 3 V to 36 V		70	80		dB
		(V–) ≤ V_{CM} ≤ (V+) – 2 V	V_S = 5 V to 36 V	T_A = –40°C to 125°C	65	80		
INPUT BIAS CURRENT								
I_B	Input bias current					-10	-35	nA
			T_A = –40°C to 125°C				-60	
dI_{OS}/dT	Input offset current drift		T_A = –40°C to 125°C			10		pA/°C
I_{OS}	Input offset current					±0.5	±4	nA
			T_A = –40°C to 125°C				±5	
dI_{OS}/dT	Input offset current drift		T_A = –40°C to 125°C			10		pA/°C
NOISE								
E_N	Input voltage noise	f = 0.1 to 10 Hz				3		µV$_{PP}$
e_N	Input voltage noise density	R_S = 100 Ω, V_I = 0 V, f = 1 kHz (see Figure 7-2 for test circuit)				35		nV/√Hz
INPUT CAPACITANCE								
Z_{ID}	Differential					10 ‖ 0.1		MΩ ‖ pF
Z_{ICM}	Common-mode					4 ‖ 1.5		GΩ ‖ pF
OPEN-LOOP GAIN								
A_{OL}	Open-loop voltage gain	V_S = 15 V, V_O = 1 V to 11 V, R_L ≥ 10 kΩ, connected to (V-)			50	100		V/mV
			T_A = –40°C to 125°C		25			
FREQUENCY RESPONSE								
GBW	Gain-bandwidth product	R_L = 1 MΩ, C_L = 20 pF (see Figure 7-1 for test circuit)				1.2		MHz
SR	Slew rate	R_L = 1 MΩ, C_L = 30 pF, V_I = ±10 V (see Figure 7-1 for test circuit)				0.5		V/µs
Θ_m	Phase margin	G = + 1, R_L = 10kΩ, C_L = 20 pF				56		°
t_S	Settling time	To 0.1%, V_S = 5 V, 2-V Step , G = +1, C_L = 100 pF				4		µs
	Overload recovery time	V_{IN} × gain > V_S				10		µs
THD+N	Total harmonic distortion + noise	G = + 1, f = 1 kHz, V_O = 3.53 V_{RMS}, V_S = 36V, R_L = 100 kΩ, I_{OUT} ≤ 50 µA, BW = 80 kHz				0.001%		
OUTPUT								
V_O	Voltage output swing from rail	Positive Rail (V+)	I_{OUT} = -50 µA			1.35	1.5	V
V_O			I_{OUT} = -1 mA			1.4	1.6	V
V_O			I_{OUT} = -5 mA			1.5	1.75	V
V_O		Negative Rail (V-)	I_{OUT} = 50 µA			100	150	mV
V_O			I_{OUT} = 1 mA			0.75	1	V
V_O			V_S = 5 V, RL ≤ 10 kΩ connected to (V–)	T_A = –40°C to 125°C		5	20	mV
I_O	Output current	V_S = 15 V; V_O = V-; V_{ID} = 1 V	Source		-20[1]	-30		mA
				T_A = –40°C to 125°C	-10[1]			mA
		V_S = 15 V; V_O = V+; V_{ID} = -1 V	Sink		10[1]	20		mA
				T_A = –40°C to 125°C	5[1]			mA
		V_{ID} = -1 V; V_O = (V-) + 200 mV			50	85		µA
I_{SC}	Short-circuit current	V_S = 20 V, (V+) = 10 V, (V-) = -10 V, V_O = 0 V				±40	±60	mA
C_{LOAD}	Capacitive load drive					100		pF

Product Folder Links: LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902 LM2902B LM2902BA LM2902K LM2902KV LM2902KAV

LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV
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5.6 Electrical Characteristics - LM2902B and LM2902BA (continued)

For $V_S = (V+) - (V-) = 5$ V to 36 V (± 2.5 V to ± 18 V), at $T_A = 25°C$, $V_{CM} = V_{OUT} = V_S / 2$, and $R_L = 10$ kΩ connected to $V_S / 2$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
R_O	Open-loop output impedance	$f = 1$ MHz, $I_O = 0$ A			300		Ω
POWER SUPPLY							
I_Q	Quiescent current per amplifier	$V_S = 5$ V; $I_O = 0$ A	$T_A = -40°C$ to 125°C		240	300	µA
		$V_S = 36$ V; $I_O = 0$ A	$T_A = -40°C$ to 125°C			750	µA

(1)   Specified by design and characterization only.

5.7 Electrical Characteristics for LM324, LM324K, LM224, LM224K, and LM124

at specified free-air temperature, V_{CC} = 5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS[1]		T_A [2]	LM124, LM224, LM224K			LM324, LM324K			UNIT
					MIN	TYP[3]	MAX	MIN	TYP[3]	MAX	
V_{IO}	Input offset voltage	V_{CC} = 5 V to MAX, V_{IC} = V_{ICR}min, V_O = 1.4 V		25°C		3	5		3	7	mV
				Full range			7			9	
I_{IO}	Input offset current	V_O = 1.4 V		25°C		2	30		2	50	nA
				Full range			100			150	
I_{IB}	Input bias current	V_O = 1.4 V		25°C		−20	−150		−20	−250	nA
				Full range			−300			−500	
V_{ICR}	Common-mode input voltage range	V_{CC} = 5 V to MAX		25°C	0 to V_{CC} − 1.5			0 to V_{CC} − 1.5			V
				Full range	0 to V_{CC} − 2			0 to V_{CC} − 2			
V_{OH}	High-level output voltage	R_L = 2 kΩ		25°C	V_{CC} − 1.5			V_{CC} − 1.5			V
		V_{CC} = MAX	R_L = 2 kΩ	Full range	26			26			
			R_L ≥ 10 kΩ	Full range	27	28		27	28		
V_{OL}	Low-level output voltage	R_L ≤ 10 kΩ		Full range		5	20		5	20	mV
A_{VD}	Large-signal differential voltage amplification	V_{CC+} = 15 V, V_O = 1 V to 11 V, R_L ≥ 2 kΩ		25°C	50	100		25	100		V/mV
				Full range	25			15			
CMRR	Common-mode rejection ratio	V_{IC} = V_{ICR}min		25°C	70	80		65	80		dB
k_{SVR}	Supply-voltage rejection ratio (ΔV_{CC} /ΔVIO)			25°C	65	100		65	100		dB
V_{O1}/ V_{O2}	Crosstalk attenuation	f = 1 kHz to 20 kHz		25°C		120			120		dB
I_O	Output current	V_{CC} = 15 V, V_{ID} = 1 V, V_O = 0	Source	25°C	−20	−30	−60	−20	−30	−60	mA
				Full range	−10			−10			
		V_{CC} = 15 V, V_{ID} = −1 V, V_O = 15 V	Sink	25°C	10	20		10	20		
				Full range	5			5			
		V_{ID} = −1 V, V_O = 200 mV		25°C	12	30		12	30		µA
I_{OS}	Short-circuit output current	V_{CC} at 5 V, V_O = 0, V_{CC-} at −5 V		25°C		±40	±60		±40	±60	mA
I_{CC}	Supply current (four amplifiers)	V_O = 2.5 V, no load		Full range		0.7	1.2		0.7	1.2	mA
		V_{CC} = MAX, V_O = 0.5 V_{CC}, no load		Full range		1.4	3		1.4	3	

(1) All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified. MAX V_{CC} for testing purposes is 26 V for LM2902 and 30 V for the others.
(2) Full range is –55°C to +125°C for LM124, –25°C to +85°C for LM224, and 0°C to 70°C for LM324.
(3) All typical values are at T_A = 25°C.

Product Folder Links: *LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902 LM2902B LM2902BA LM2902K LM2902KV LM2902KAV*

LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV
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5.8 Electrical Characteristics for LM2902, LM2902K, LM2902KV and LM2902KAV

at specified free-air temperature, V_{CC} = 5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS[1]		T_A [2]	LM2902, LM2902K			LM2902KV, LM2902KAV			UNIT
					MIN	TYP[3]	MAX	MIN	TYP[3]	MAX	
V_{IO}	Input offset voltage	V_{CC} = 5 V to MAX, V_{IC} = V_{ICR}min, V_O = 1.4 V	Non-A-suffix devices	25°C		3	7		3	7	mV
				Full range			10			10	
			A-suffix devices	25°C					1	2	
				Full range						4	
$\Delta V_{IO}/\Delta T$	Input offset voltage temperature drift	R_S = 0 Ω		Full range					7		µV/°C
I_{IO}	Input offset current	V_O = 1.4 V		25°C		2	50		2	50	nA
				Full range			300			150	
$\Delta I_{IO}/\Delta T$	Input offset voltage temperature drift			Full range					10		pA/°C
I_{IB}	Input bias current	V_O = 1.4 V		25°C		–20	–250		–20	–250	nA
				Full range			–500			–500	
V_{ICR}	Common-mode input voltage range	V_{CC} = 5 V to MAX		25°C	0 to V_{CC} – 1.5			0 to V_{CC} – 1.5			V
				Full range	0 to V_{CC} – 2			0 to V_{CC} – 2			
V_{OH}	High-level output voltage	R_L = 10 kΩ		25°C	V_{CC} – 1.5			V_{CC} – 1.5			V
		V_{CC} = MAX	R_L = 2 kΩ	Full range	22			26			
			R_L ≥ 10 kΩ	Full range	23	24		27			
V_{OL}	Low-level output voltage	R_L ≤ 10 kΩ		Full range		5	20		5	20	mV
A_{VD}	Large-signal differential voltage amplification	V_{CC} = 15 V, V_O = 1 V to 11 V, R_L ≥ 2 kΩ		25°C	25	100		25	100		V/mV
				Full range	15			15			
CMRR	Common-mode rejection ratio	V_{IC} = V_{ICR}min		25°C	50	80		60	80		dB
k_{SVR}	Supply-voltage rejection ratio (ΔV_{CC} /ΔV_{IO})			25°C	50	100		60	100		dB
V_{O1}/V_{O2}	Crosstalk attenuation	f = 1 kHz to 20 kHz		25°C		120			120		dB
I_O	Output current	V_{CC} = 15 V, V_{ID} = 1 V, V_O = 0	Source	25°C	–20	–30	–60	–20	–30	–60	mA
				Full range	–10			–10			
		V_{CC} = 15 V, V_{ID} = –1 V, V_O = 15 V	Sink	25°C	10	20		10	20		
				Full range	5			5			
		V_{ID} = –1 V, V_O = 200 mV		25°C		30		12	40		µA
I_{OS}	Short-circuit output current	V_{CC} at 5 V, V_O = 0, V_{CC}- at –5 V		25°C		±40	±60		±40	±60	mA
I_{CC}	Supply current (four amplifiers)	V_O = 2.5 V, no load		Full range		0.7	1.2		0.7	1.2	mA
		V_{CC} = MAX, V_O = 0.5 V_{CC}, no load		Full range		1.4	3		1.4	3	

(1) All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified. MAX V_{CC} for testing purposes is 26 V for LM2902 and 32 V for LM2902V.

(2) Full range is –40°C to +125°C for LM2902.

(3) All typical values are at T_A = 25°C.

Product Folder Links: *LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902 LM2902B LM2902BA LM2902K LM2902KV LM2902KAV*

**LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV**

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5.9 Electrical Characteristics for LM324A, LM324KA, LM224A, LM224KA, and LM124A

at specified free-air temperature, V_{CC} = 5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS[1]		T_A [2]	LM124A			LM224A, LM224KA			LM324A, LM324KA			UNIT
					MIN	TYP[3]	MAX	MIN	TYP[3]	MAX	MIN	TYP[3]	MAX	
V_{IO}	Input offset voltage	V_{CC} = 5 V to 30 V, V_{IC} = V_{ICR}min, V_O = 1.4 V		25°C			2		2	3		2	3	mV
				Full range			4			4			5	
I_{IO}	Input offset current	V_O = 1.4 V		25°C			10		2	15		2	30	nA
				Full range			30			30			75	
I_{IB}	Input bias current	V_O = 1.4 V		25°C			−50		−15	−80		−15	−100	nA
				Full range			−100			−100			−200	
V_{ICR}	Common-mode input voltage range	V_{CC} = 30 V		25°C	0 to V_{CC} − 1.5			0 to V_{CC} − 1.5			0 to V_{CC} − 1.5			V
				Full range	0 to V_{CC} − 2			0 to V_{CC} − 2			0 to V_{CC} − 2			
V_{OH}	High-level output voltage	R_L = 2 kΩ		25°C	V_{CC} − 1.5			V_{CC} − 1.5			V_{CC} − 1.5			V
		V_{CC} = 30 V	R_L = 2 kΩ	Full range	26			26			26			
			R_L ≥ 10 kΩ	Full range	27			27	28		27	28		
V_{OL}	Low-level output voltage	R_L ≤ 10 kΩ		Full range			20		5	20		5	20	mV
A_{VD}	Large-signal differential voltage amplification	V_{CC} = 15 V, V_O = 1 V to 11 V, R_L ≥ 2 kΩ		25°C	50	100		50	100		25	100		V/mV
				Full range	25			25			15			
CMRR	Common-mode rejection ratio	V_{IC} = V_{ICR}min		25°C	70			70	80		65	80		dB
k_{SVR}	Supply-voltage rejection ratio (ΔV_{CC} /ΔV_{IO})			25°C	65			65	100		65	100		dB
V_{O1}/ V_{O2}	Crosstalk attenuation	f = 1 kHz to 20 kHz		25°C		120			120			120		dB
I_O	Output current	V_{CC} = 15 V, V_{ID} = 1 V, V_O = 0	Source	25°C	−20			−20	−30	−60	−20	−30	−60	mA
				Full range	−10			−10			−10			
		V_{CC} = 15 V, V_{ID} = −1 V, V_O = 15 V	Sink	25°C	10			10	20		1	20		
				Full range	5			5			5			
		V_{ID} = −1 V, V_O = 200 mV		25°C	12			12	30		12	30		µA
I_{OS}	Short-circuit output current	V_{CC} at 5 V, V_{CC-} at −5 V, V_O = 0		25°C		±40	±60		±40	±60		±40	±60	mA
I_{CC}	Supply current (four amplifiers)	V_O = 2.5 V, no load		Full range		0.7	1.2		0.7	1.2		0.7	1.2	mA
		V_{CC} = 30 V, V_O = 15 V, no load		Full range		1.4	3.		1.4	3		1.4	3	

(1)   All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified.
(2)   Full range is –55°C to +125°C for LM124A, –25°C to +85°C for LM224A, and 0°C to 70°C for LM324A.
(3)   All typical values are at T_A = 25°C.

5.10 Operating Conditions

V_{CC} = ±15 V, T_A = 25°C

	PARAMETER	TEST CONDITIONS	TYP	UNIT
SR	Slew rate at unity gain	R_L = 1 MΩ, C_L = 30 pF, V_I = ±10 V (see Figure 6-1)	0.5	V/µs
B_1	Unity-gain bandwidth	R_L = 1 MΩ, C_L = 20 pF (see Figure 6-1)	1.2	MHz
V_n	Equivalent input noise voltage	R_S = 100 Ω, V_I = 0 V, f = 1 kHz (see Figure 6-2)	35	nV/√Hz

Product Folder Links: *LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902 LM2902B LM2902BA LM2902K LM2902KV LM2902KAV*

LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV
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5.11 Typical Characteristics

This typical characteristics section is applicable for LM324B and LM2902B. Typical characteristics data in this section was taken with T_A = 25°C, V_S = 36 V (±18 V), V_{CM} = V_S / 2, R_{LOAD} = 10 kΩ connected to V_S / 2 (unless otherwise noted).
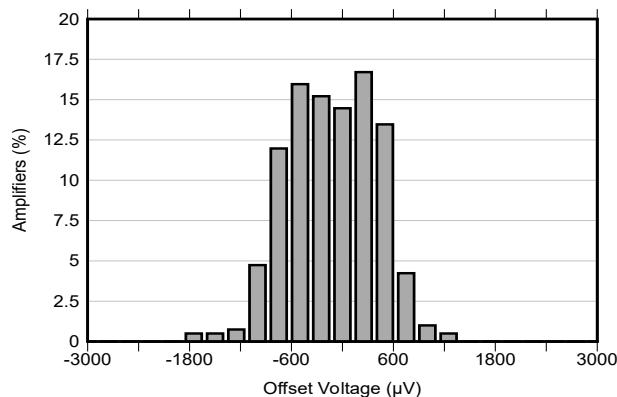
Figure 5-1. Offset Voltage Production Distribution
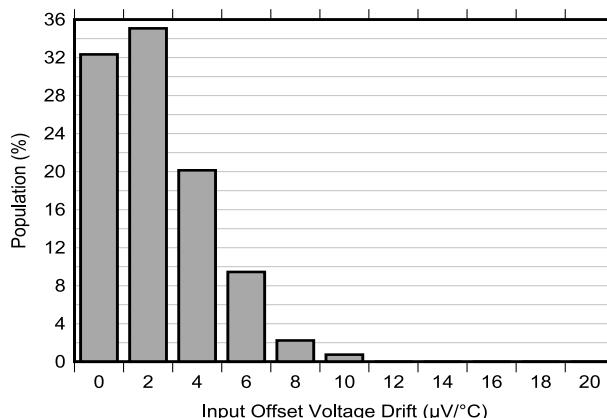
Figure 5-2. Offset Voltage Drift Distribution
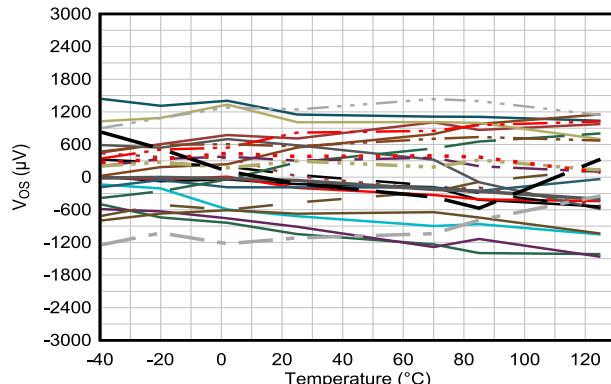
Figure 5-3. Offset Voltage vs Temperature
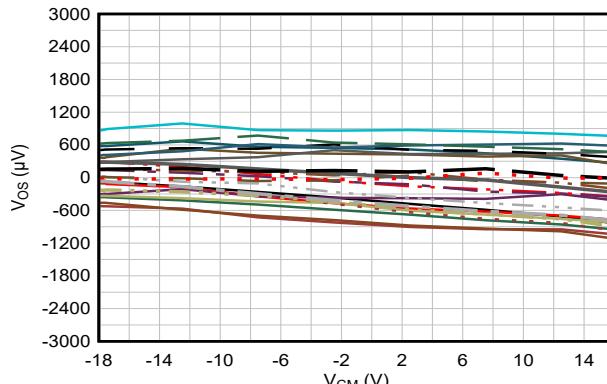
Figure 5-4. Offset Voltage vs Common-Mode Voltage
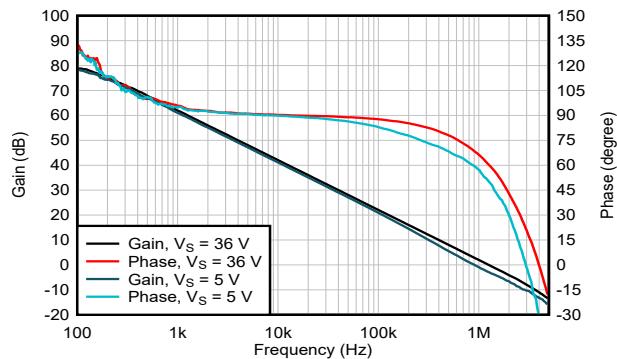
Figure 5-5. Open-Loop Gain and Phase vs Frequency
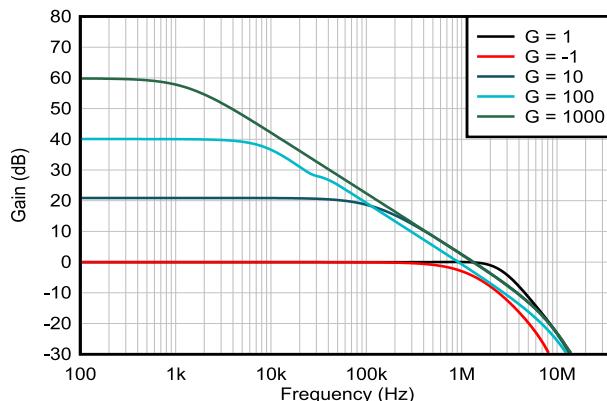
Figure 5-6. Closed-Loop Gain vs Frequency

Product Folder Links: *LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902 LM2902B LM2902BA LM2902K LM2902KV LM2902KAV*

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LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV
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5.11 Typical Characteristics (continued)

This typical characteristics section is applicable for LM324B and LM2902B. Typical characteristics data in this section was taken with T_A = 25°C, V_S = 36 V (±18 V), V_{CM} = V_S / 2, R_{LOAD} = 10 kΩ connected to V_S / 2 (unless otherwise noted).
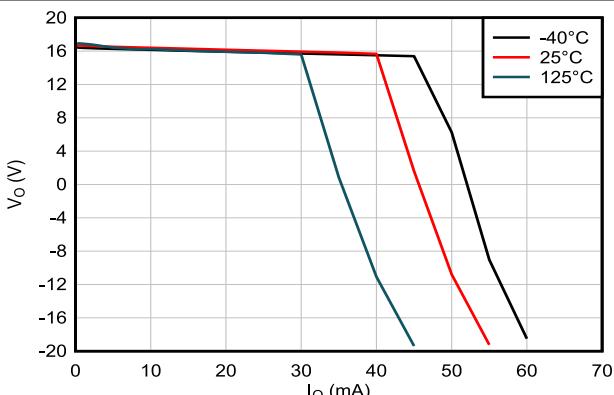
Figure 5-7. Output Voltage Swing vs Output Current (Sourcing)
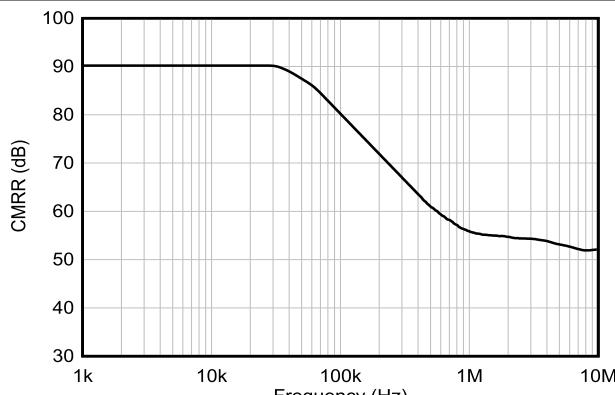
Figure 5-8. CMRR vs Frequency
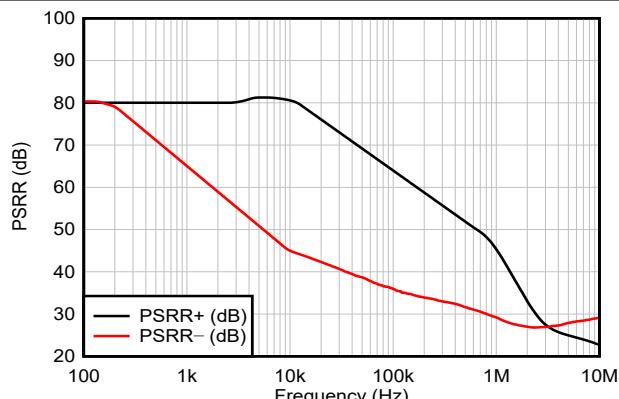
**Figure 5-9. PSRR vs Frequency**
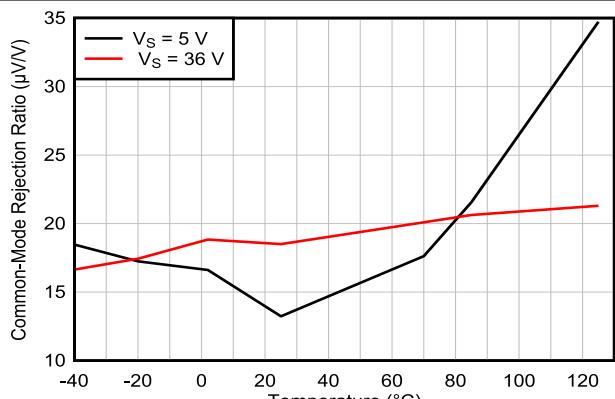
Figure 5-10. Common-Mode Rejection Ratio vs Temperature
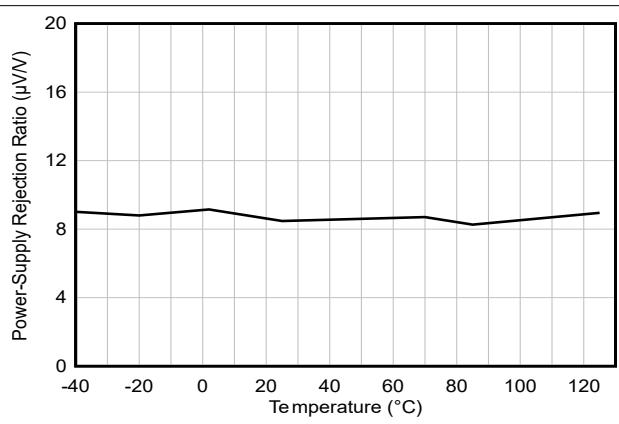

**Figure 5-11. Power Supply Rejection Ratio vs Temperature**
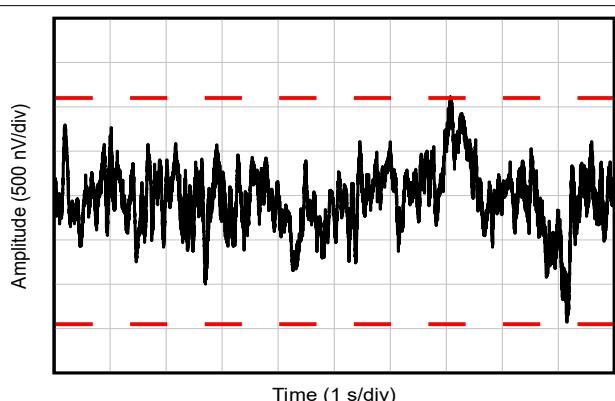
Figure 5-12. 0.1-Hz to 10-Hz Noise

5.11 Typical Characteristics (continued)

This typical characteristics section is applicable for LM324B and LM2902B. Typical characteristics data in this section was taken with T_A = 25°C, V_S = 36 V (±18 V), V_{CM} = V_S / 2, R_{LOAD} = 10 kΩ connected to V_S / 2 (unless otherwise noted).
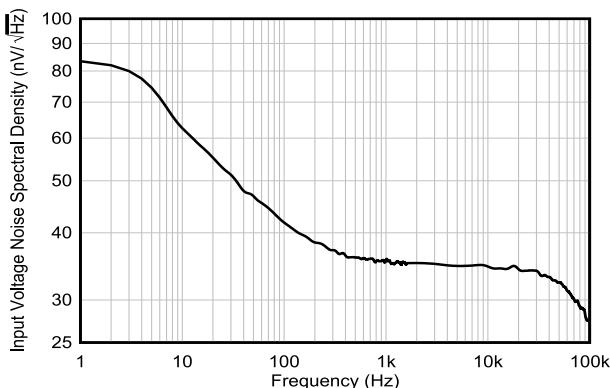
Figure 5-13. Input Voltage Noise Spectral Density vs Frequency

G = 1, f = 1 kHz, BW = 80 kHz,
V_{OUT} = 10 V_{PP}, R_L connected to V–
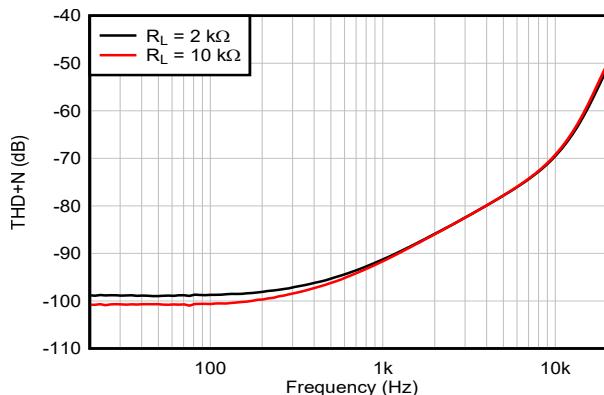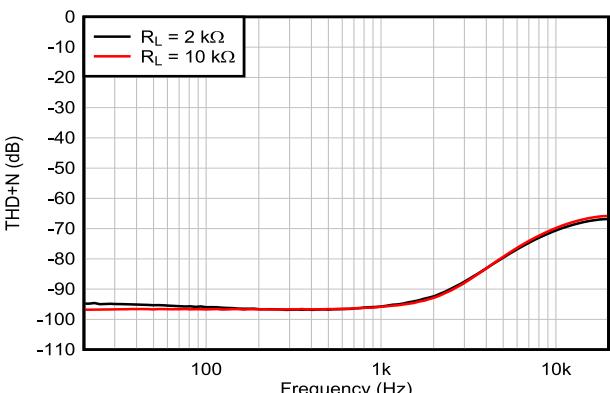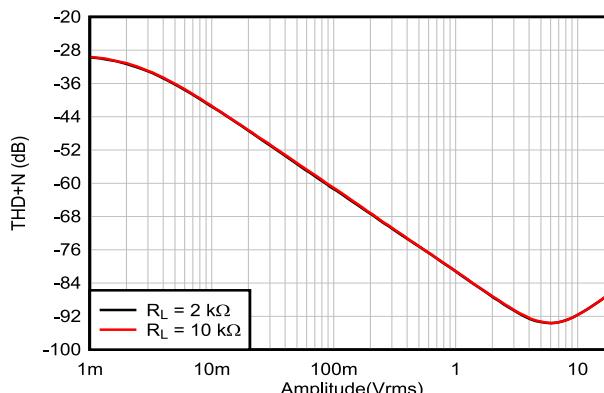
Figure 5-14. THD+N Ratio vs Frequency, G = 1
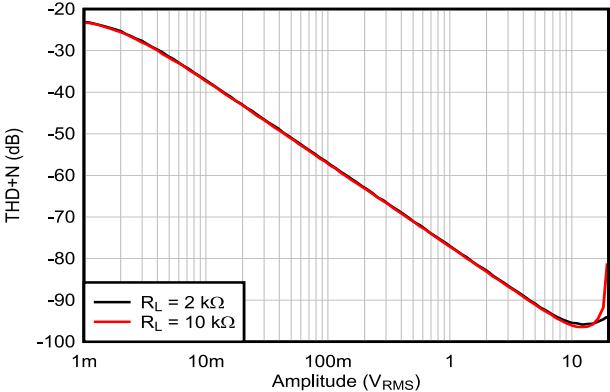
G = –1, f = 1 kHz, BW = 80 kHz,
V_{OUT} = 10 V_{PP}, R_L connected to V–
See Section 6

Figure 5-15. THD+N Ratio vs Frequency, G = –1

G = 1, f = 1 kHz, BW = 80 kHz,
R_L connected to V–

Figure 5-16. THD+N vs Output Amplitude, G = 1

G = –1, f = 1 kHz, BW = 80 kHz,
R_L connected to V–
See Section 6

Figure 5-17. THD+N vs Output Amplitude, G = –1
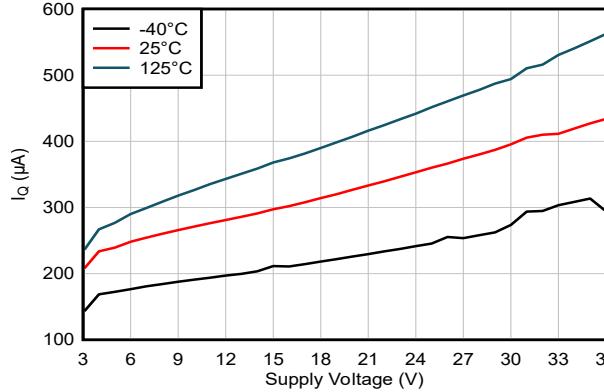
Figure 5-18. Quiescent Current vs Supply Voltage

Product Folder Links: *LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902 LM2902B LM2902BA LM2902K LM2902KV LM2902KAV*

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LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV
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5.11 Typical Characteristics (continued)

This typical characteristics section is applicable for LM324B and LM2902B. Typical characteristics data in this section was taken with T_A = 25°C, V_S = 36 V (±18 V), V_{CM} = V_S / 2, R_{LOAD} = 10 kΩ connected to V_S / 2 (unless otherwise noted).
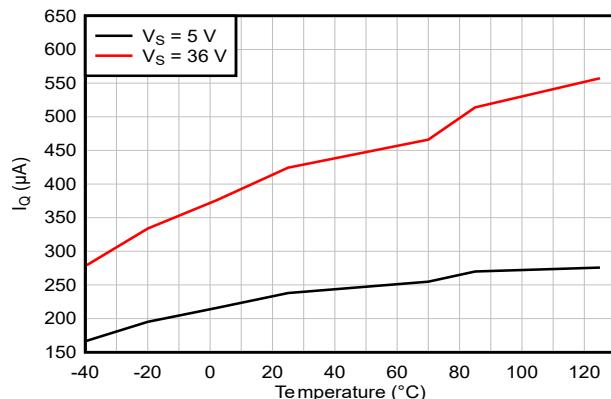
Figure 5-19. Quiescent Current vs Temperature
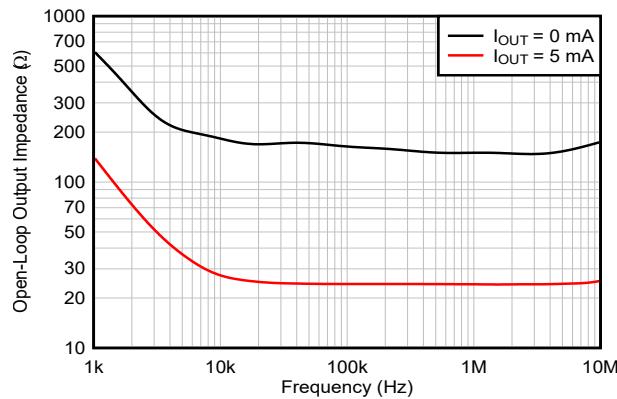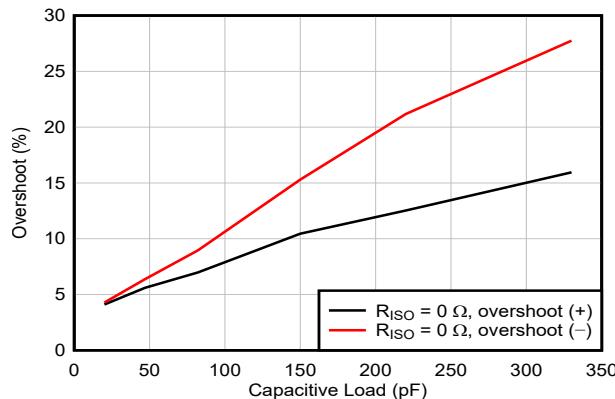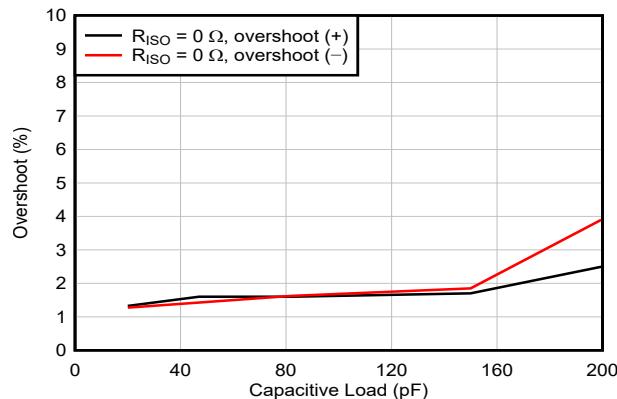
Figure 5-20. Open-Loop Output Impedance vs Frequency
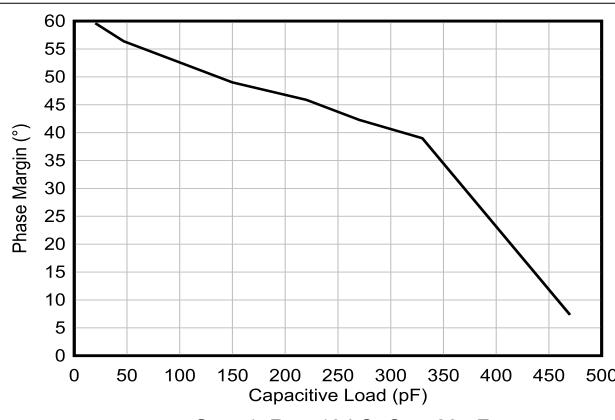
G = 1, 100-mV output step, R_L = open

Figure 5-21. Small-Signal Overshoot vs Capacitive Load
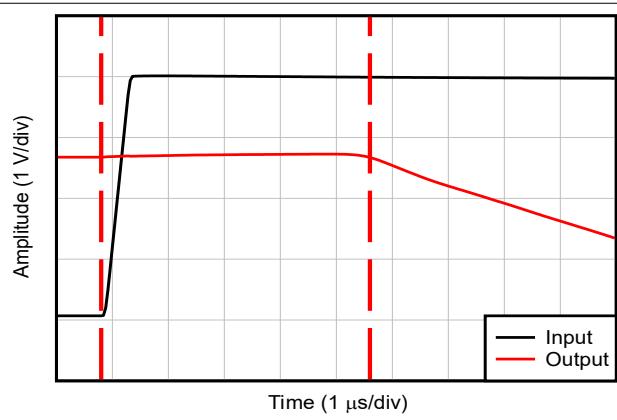
G = –1, 100-mV output step, R_L = open

Figure 5-22. Small-Signal Overshoot vs Capacitive Load

G = +1, R_L = 10 kΩ, C_L = 20 pF

Figure 5-23. Phase Margin vs Capacitive Load
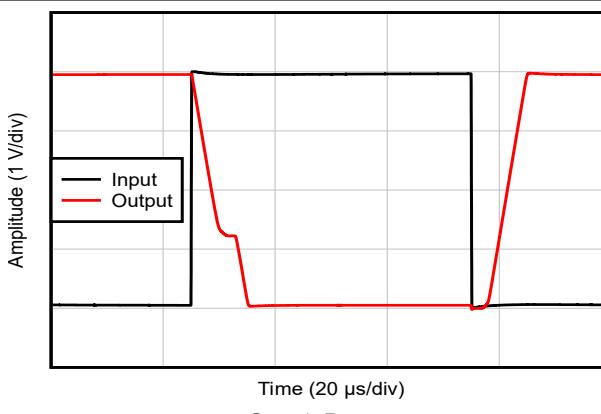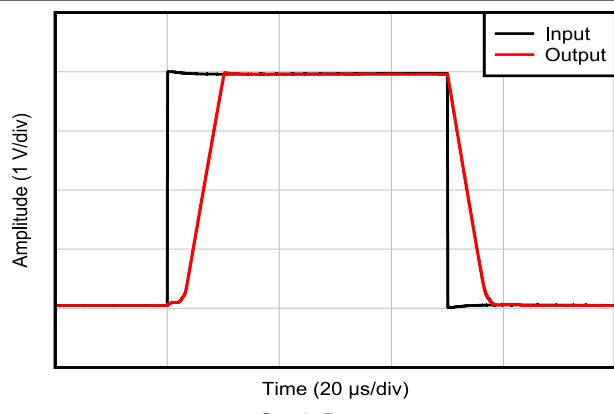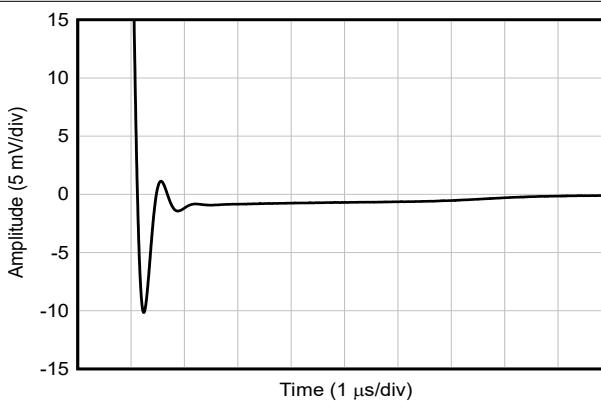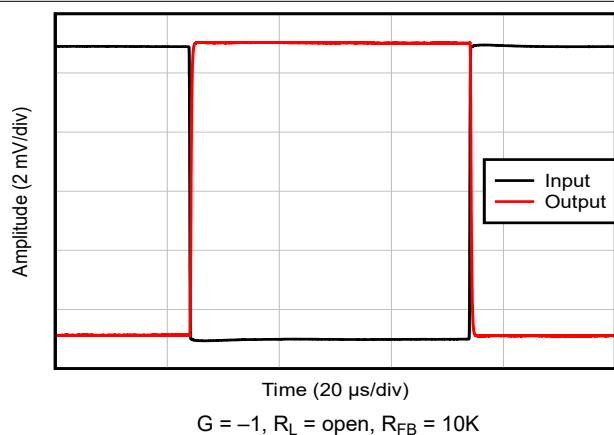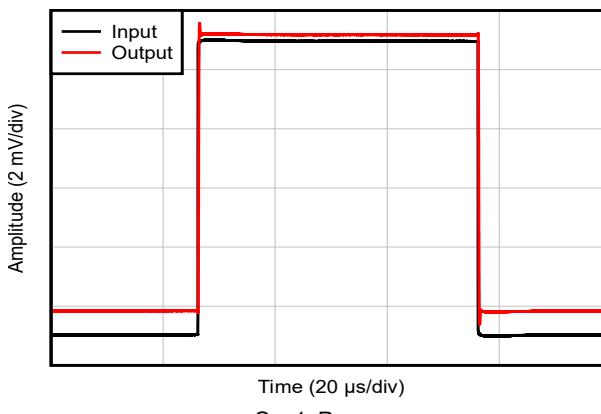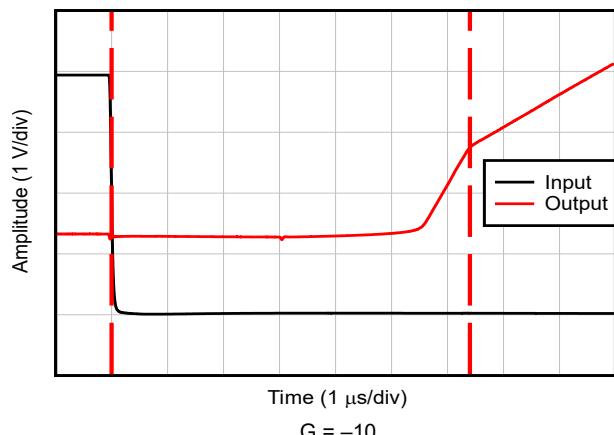
G = –10

Figure 5-24. Overload Recovery (Positive Rail)

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LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV
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5.11 Typical Characteristics (continued)

This typical characteristics section is applicable for LM324B and LM2902B. Typical characteristics data in this section was taken with $T_A = 25°C$, $V_S = 36$ V (±18 V), $V_{CM} = V_S / 2$, $R_{LOAD} = 10$ kΩ connected to $V_S / 2$ (unless otherwise noted).

Time (1 µs/div)

G = –10

Figure 5-25. Overload Recovery (Negative Rail)

Time (20 µs/div)

G = 1, R_L = open

Figure 5-26. Small-Signal Step Response, G = 1

Time (20 µs/div)

G = –1, R_L = open, R_{FB} = 10K

See Section 6

Figure 5-27. Small-Signal Step Response, G = –1

Time (1 µs/div)

G = 1, R_L = open

Figure 5-28. Large-Signal Step Response (Falling)

Time (20 µs/div)

G = 1, R_L = open

Figure 5-29. Large-Signal Step Response, G = 1

Time (20 µs/div)

G = –1, R_L = open

Figure 5-30. Large-Signal Step Response, G = –1

Product Folder Links: *LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902 LM2902B LM2902BA LM2902K LM2902KV LM2902KAV*

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**LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV**
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5.11 Typical Characteristics (continued)

This typical characteristics section is applicable for LM324B and LM2902B. Typical characteristics data in this section was taken with $T_A = 25°C$, $V_S = 36$ V (±18 V), $V_{CM} = V_S / 2$, $R_{LOAD} = 10$ kΩ connected to $V_S / 2$ (unless otherwise noted).

Figure 5-31. Short-Circuit Current vs Temperature

$V_S = 15$ V
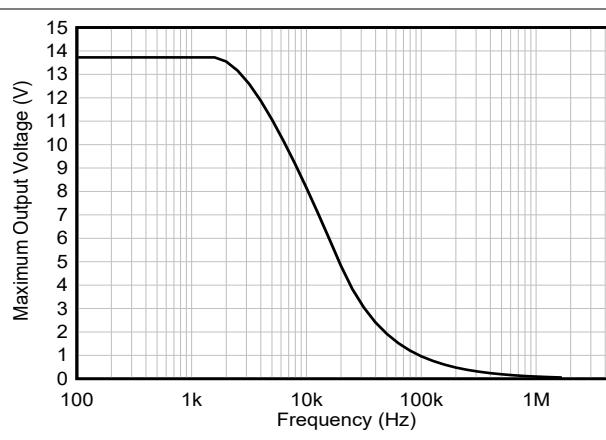
Figure 5-32. Maximum Output Voltage vs Frequency
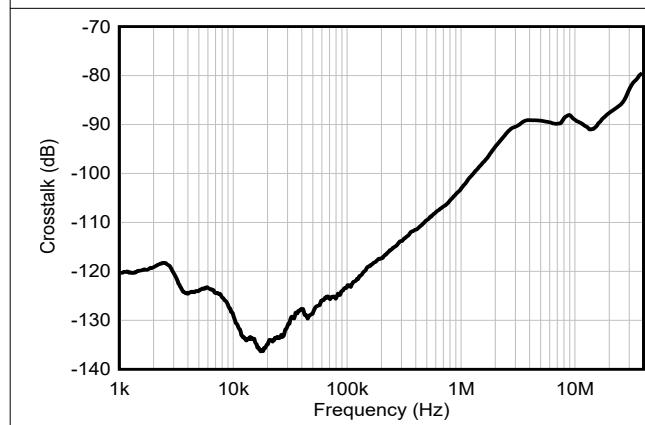
Figure 5-33. Channel Separation vs Frequency
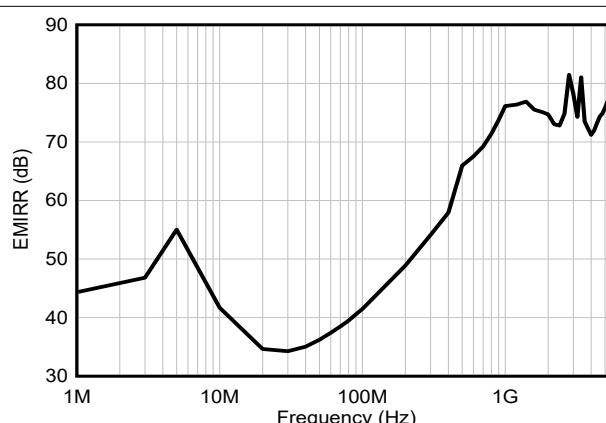
Figure 5-34. EMIRR (Electromagnetic Interference Rejection Ratio) vs Frequency

LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
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5.12 Typical Characteristics: All Devices Except B and BA Versions
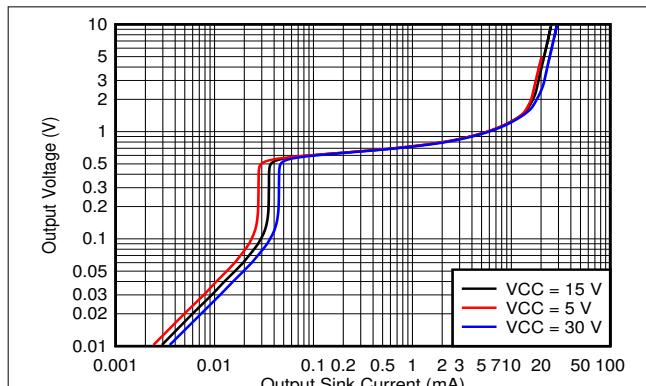
Figure 5-35. Output Sinking Characteristics
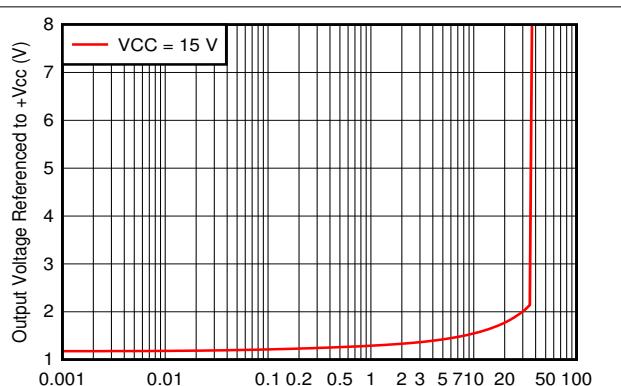
Figure 5-36. Output Sourcing Characteristics
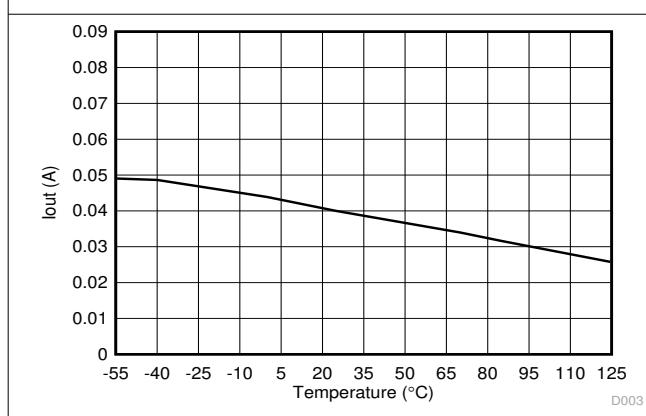
Figure 5-37. Source Current Limiting
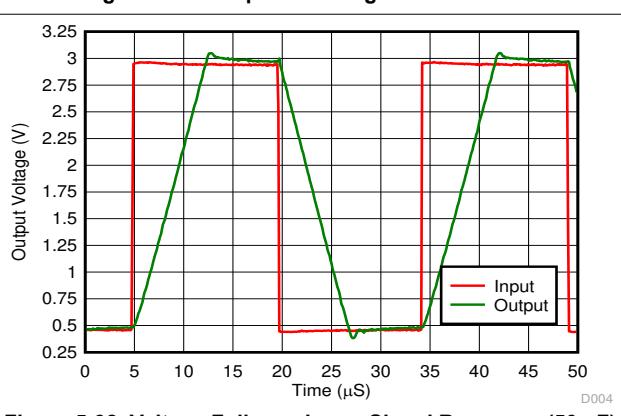
Figure 5-38. Voltage Follower Large Signal Response (50 pF)
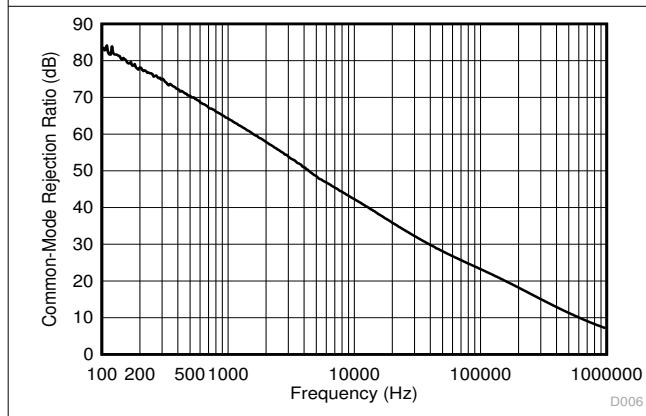
Figure 5-39. Common-Mode Rejection Ratio
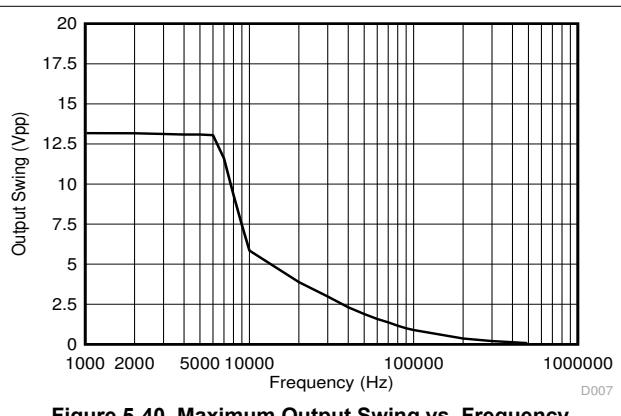
Figure 5-40. Maximum Output Swing vs. Frequency (VCC = 15 V)

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LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
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6 Parameter Measurement Information
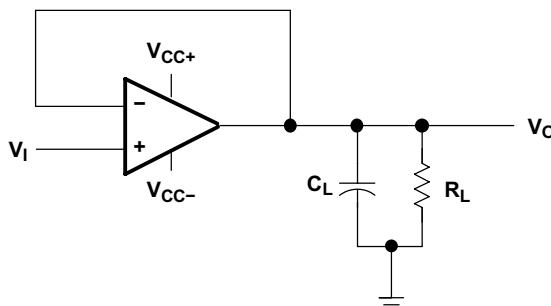
Figure 6-1. Unity-Gain Amplifier
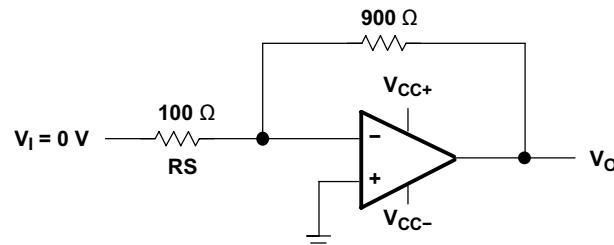
Figure 6-2. Noise-Test Circuit
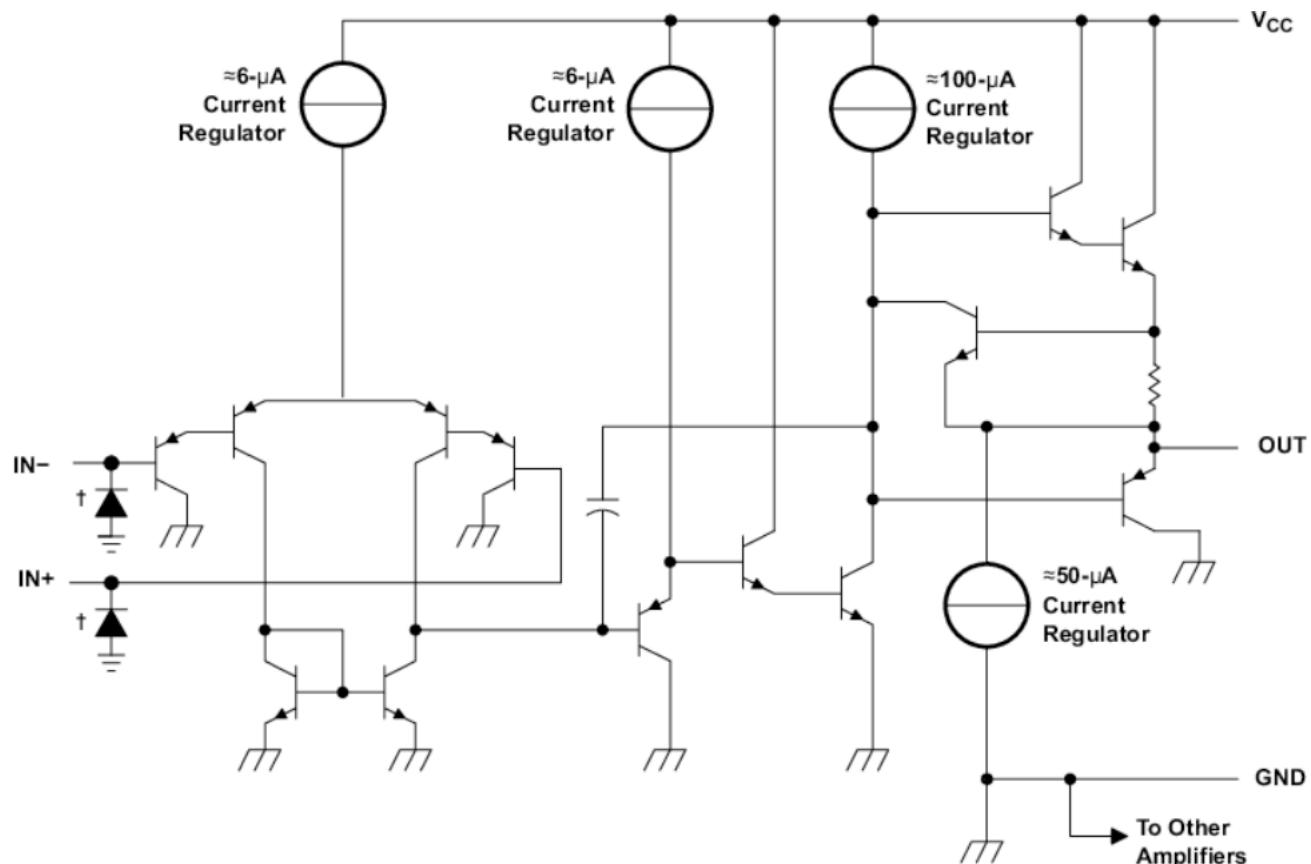
7 Detailed Description

7.1 Overview

These devices consist of four independent high-gain frequency-compensated operational amplifiers that are designed specifically to operate from a single supply over a wide range of voltages. Operation from split supplies is also possible if the difference between the two supplies is 3 V to 36 V (B and BA versions), 3 V to 26 V (for LM2902 devices), or 3 V to 30 V (for all other devices), and V_{CC} is at least 1.5 V more positive than the input common-mode voltage. The low supply-current drain is independent of the magnitude of the supply voltage.

Applications include transducer amplifiers, DC amplification blocks, and all the conventional operational-amplifier circuits that can be more easily implemented in single-supply-voltage systems. For example, the LM324B and LM2902B devices can be operated directly from the standard 5-V supply that is used in digital systems and provides the required interface electronics, without requiring additional ±15-V supplies.

7.2 Functional Block Diagram

COMPONENT COUNT (total device)	
Epi-FET	1
Transistors	95
Diodes	4
Resistors	11
Capacitors	4

ESD protection cells - available on B, BA, and K versions only

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7.3 Feature Description

7.3.1 Unity-Gain Bandwidth

Gain bandwidth product is found by multiplying the measured bandwidth of an amplifier by the gain at which that bandwidth was measured. These devices have a high gain bandwidth of 1.2 MHz.

7.3.2 Slew Rate

The slew rate is the rate at which an operational amplifier can change the output when there is a change on the input. These devices have a 0.5-V/µs slew rate.

7.3.3 Input Common Mode Range

The valid common mode range is from device ground to V_{CC} – 1.5 V (V_{CC} – 2 V across temperature). Inputs may exceed V_{CC} up to the maximum V_{CC} without device damage. At least one input must be in the valid input common mode range for output to be correct phase. If both inputs exceed valid range, then output phase is undefined. If either input is less than –0.3 V, then input current should be limited to 1 mA and output phase is undefined.

7.4 Device Functional Modes

These devices are powered on when the supply is connected. This device can be operated as a single supply operational amplifier or dual supply amplifier depending on the application.

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8 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

8.1 Application Information

The LMx24 and LM2902 operational amplifiers are useful in a wide range of signal conditioning applications. Inputs can be powered before VCC for flexibility in multiple supply circuits.

8.2 Typical Application

A typical application for an operational amplifier in an inverting amplifier. This amplifier takes a positive voltage on the input, and makes it a negative voltage of the same magnitude. In the same manner, it also makes negative voltages positive.
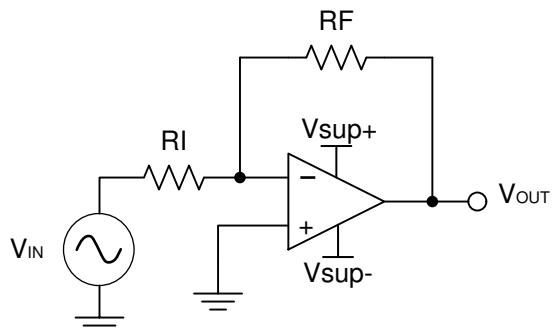
Figure 8-1. Application Schematic

8.2.1 Design Requirements

The supply voltage must be chosen such that it is larger than the input voltage range and output range. For instance, this application will scale a signal of ±0.5 V to ±1.8 V. Setting the supply at ±12 V is sufficient to accommodate this application.

8.2.2 Detailed Design Procedure

Determine the gain required by the inverting amplifier using Equation 1 and Equation 2:

$$A_V = \frac{VOUT}{VIN} \tag{1}$$

$$A_V = \frac{1.8}{-0.5} = -3.6 \tag{2}$$

Once the desired gain is determined, choose a value for RI or RF. Choosing a value in the kΩ range is desirable because the amplifier circuit uses currents in the mA range. This choice makes sure that the part does not draw too much current. This example chooses 10 kΩ for RI, which means 36 kΩ is used for RF. This was determined by Equation 3.

$$A_V = \frac{RF}{RI} \tag{3}$$

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8.2.3 Application Curve
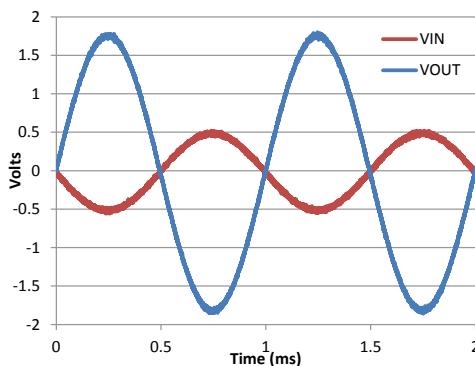
Figure 8-2. Input and Output Voltages of the Inverting Amplifier

8.3 Power Supply Recommendations

CAUTION
Supply voltages larger than 32 V for a single supply, or outside the range of ±16 V for a dual supply can permanently damage the device (see the Section 5.1).

Place 0.1-µF bypass capacitors close to the power-supply pins to reduce errors coupling in from noisy or high impedance power supplies. For more detailed information on bypass capacitor placement, refer to the Section 8.4.

8.4 Layout

8.4.1 Layout Guidelines

For best operational performance of the device, use good PCB layout practices, including:

- Noise can propagate into analog circuitry through the power pins of the circuit as a whole, as well as the operational amplifier. Bypass capacitors are used to reduce the coupled noise by providing low impedance power sources local to the analog circuitry.
  - Connect low-ESR, 0.1-µF ceramic bypass capacitors between each supply pin and ground, placed as close to the device as possible. A single bypass capacitor from V+ to ground is applicable for single supply applications.
- Separate grounding for analog and digital portions of circuitry is one of the simplest and most-effective methods of noise suppression. One or more layers on multilayer PCBs are usually devoted to ground planes. A ground plane helps distribute heat and reduces EMI noise pickup. Make sure to physically separate digital and analog grounds, paying attention to the flow of the ground current.
- To reduce parasitic coupling, run the input traces as far away from the supply or output traces as possible. If it is not possible to keep them separate, it is much better to cross the sensitive trace perpendicular as opposed to in parallel with the noisy trace.
- Place the external components as close to the device as possible. Keeping RF and RG close to the inverting input minimizes parasitic capacitance, as shown in Section 8.4.2.
- Keep the length of input traces as short as possible. Always remember that the input traces are the most sensitive part of the circuit.
- Consider a driven, low-impedance guard ring around the critical traces. A guard ring can significantly reduce leakage currents from nearby traces that are at different potentials.

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8.4.2 Layout Examples
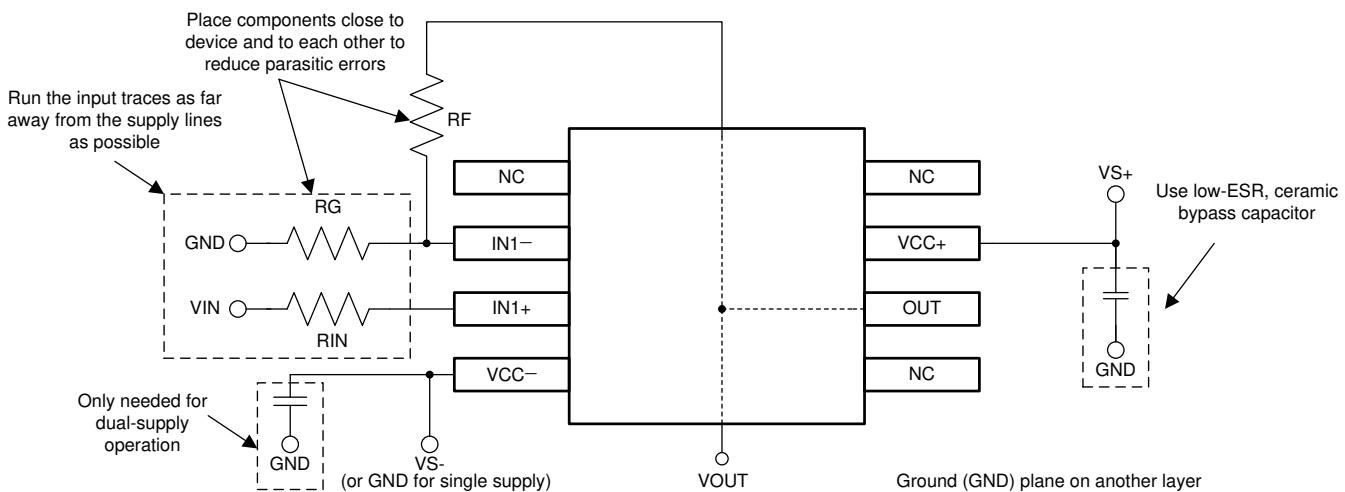
Figure 8-3. Operational Amplifier Board Layout for Noninverting Configuration
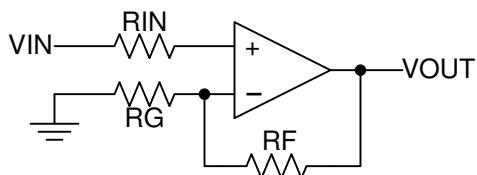
Figure 8-4. Operational Amplifier Schematic for Noninverting Configuration

Product Folder Links: *LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902 LM2902B LM2902BA LM2902K LM2902KV LM2902KAV*

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9 Device and Documentation Support

9.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

9.2 Support Resources

TI E2E™ support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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9.3 Trademarks

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9.4 Electrostatic Discharge Caution

![ESD warning symbol] This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

9.5 Glossary

TI Glossary   This glossary lists and explains terms, acronyms, and definitions.

10 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV
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11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser based versions of this data sheet, refer to the left hand navigation.

LM124, LM124A, LM224, LM224A, LM224K, LM224KA
LM324, LM324A, LM324B, LM324BA, LM324K, LM324KA
LM2902, LM2902B, LM2902BA, LM2902K, LM2902KV, LM2902KAV

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11.1 Package Option Addendum

Packaging Information

Orderable Device	Status[1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan[2]	Lead/Ball Finish[6]	MSL Peak Temp[3]	Op Temp (°C)	Device Marking[4] [5]
LM324BIRTER	PREVIEW	WQFN	RTE	16	5000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM324B
LM2902BIRTER	PREVIEW	WQFN	RTE	16	5000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2902B

(1) The marketing status values are defined as follows:
   ACTIVE: Product device recommended for new designs.
   LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
   NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
   PRE_PROD Unannounced device, not in production, not available for mass market, nor on the web, samples not available.
   PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
   OBSOLETE: TI has discontinued the production of the device.
(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check www.ti.com/productcontent for the latest availability information and additional product content details.
   TBD: The Pb-Free/Green conversion plan has not been defined.
   Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
   Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
   Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material).
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
(5) Multiple Device markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.
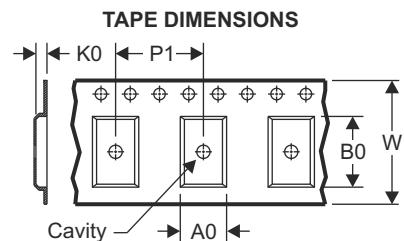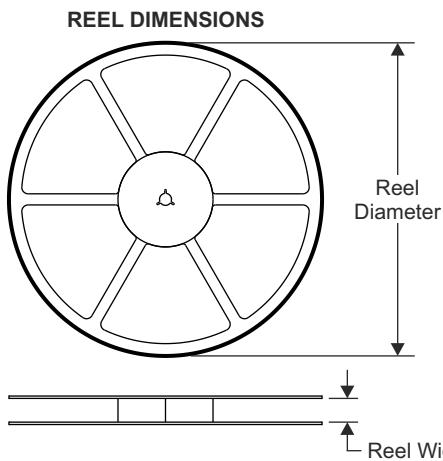
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11.2 Tape and Reel Information

REEL DIMENSIONS

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM324BIRTER	WQFN	RTE	16	5000	330	12.4	3.3	3.3	1.1	8	12	Q2
LM2902BIRTER	WQFN	RTE	16	5000	330	12.4	3.3	3.3	1.1	8	12	Q2

Product Folder Links: *LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902 LM2902B LM2902BA LM2902K LM2902KV LM2902KAV*

TAPE AND REEL BOX DIMENSIONS

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM324BIRTER	WQFN	RTE	16	5000	367.0	367.0	35.0
LM2902BIRTER	WQFN	RTE	16	5000	367.0	367.0	35.0
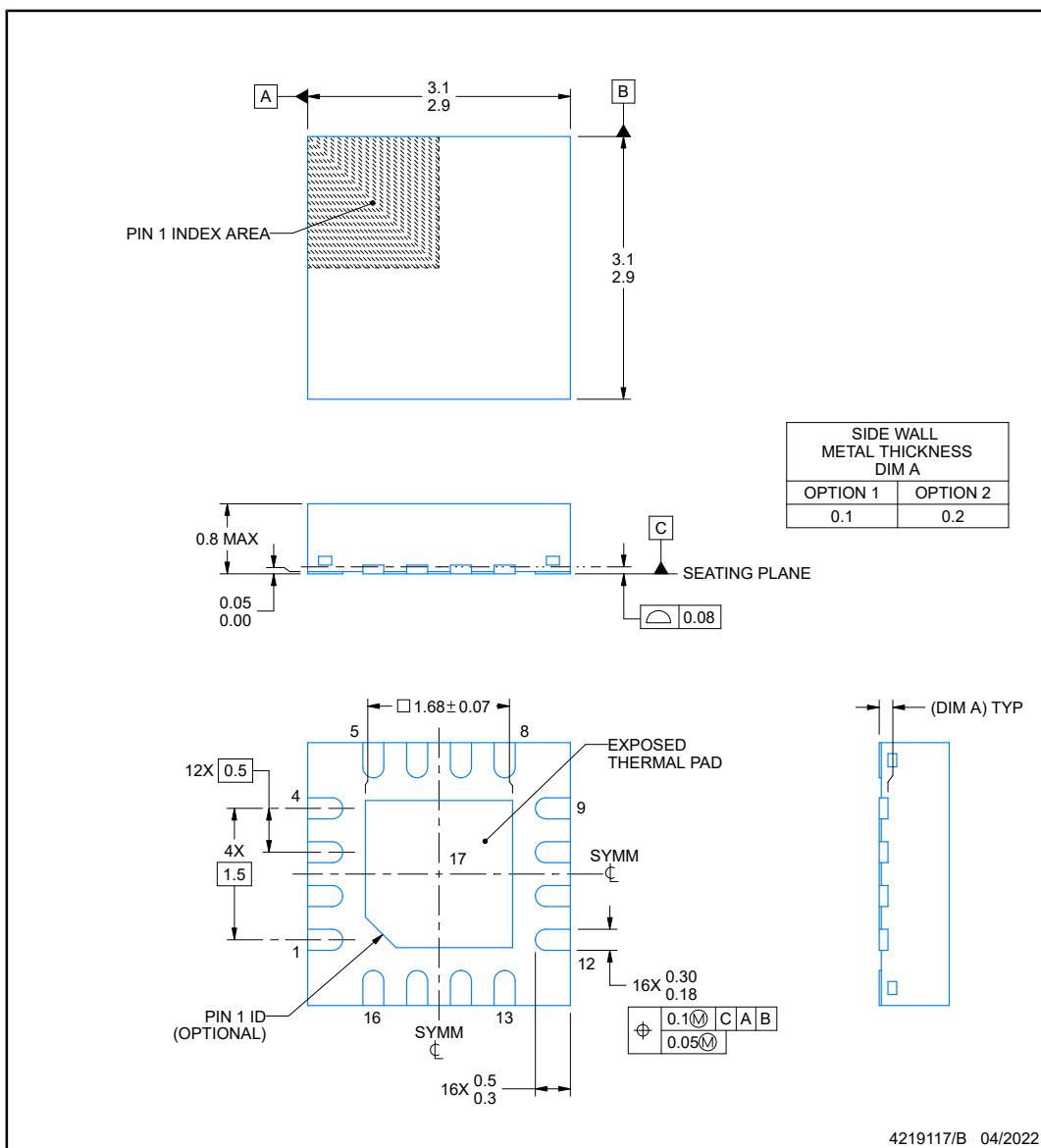
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PACKAGE OUTLINE

RTE0016C

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD

SIDE WALL METAL THICKNESS DIM A	
OPTION 1	OPTION 2
0.1	0.2

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NOTES:
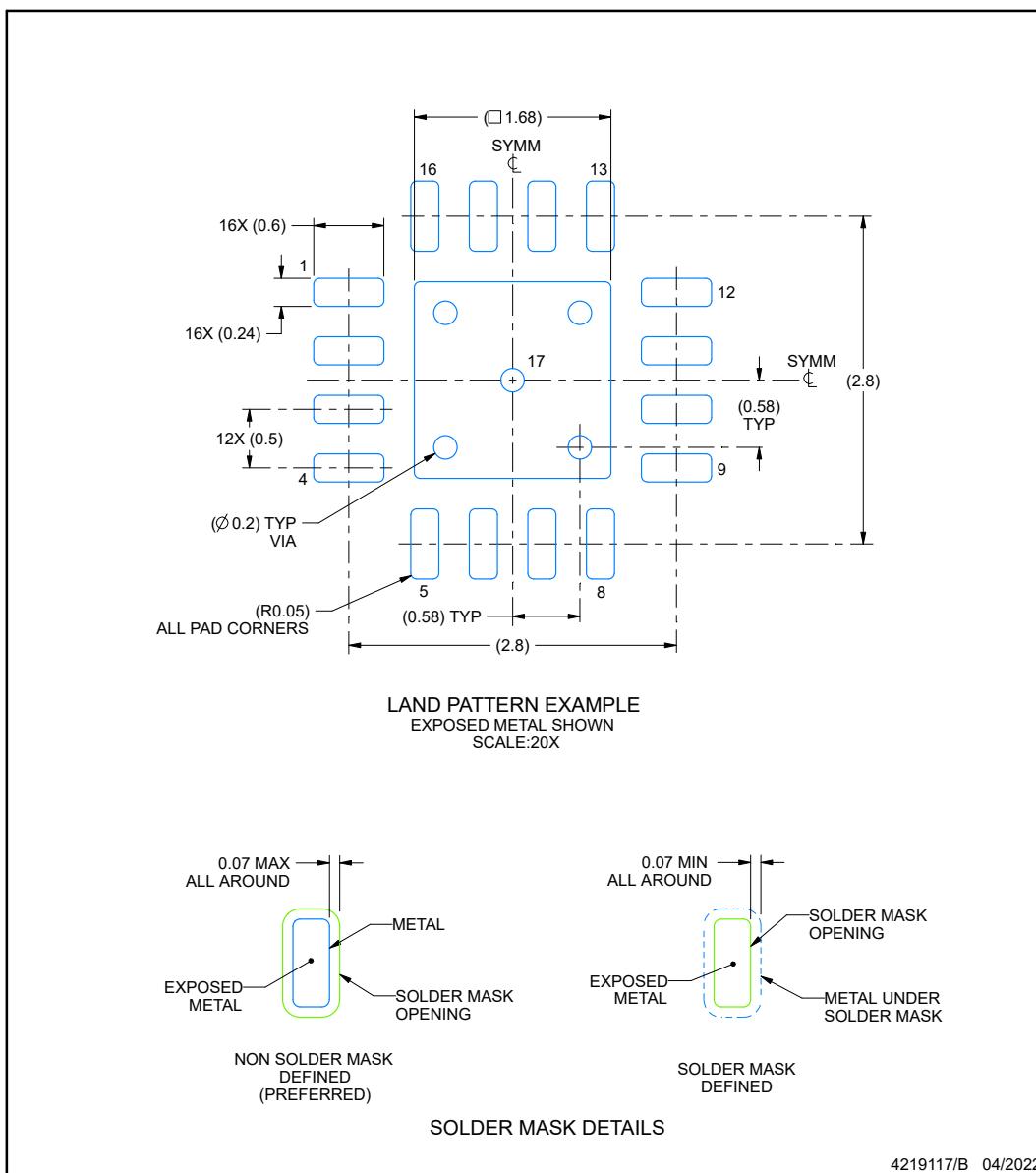
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

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EXAMPLE BOARD LAYOUT

RTE0016C   WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD

LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:20X

SOLDER MASK DETAILS

4219117/B 04/2022

NOTES: (continued)
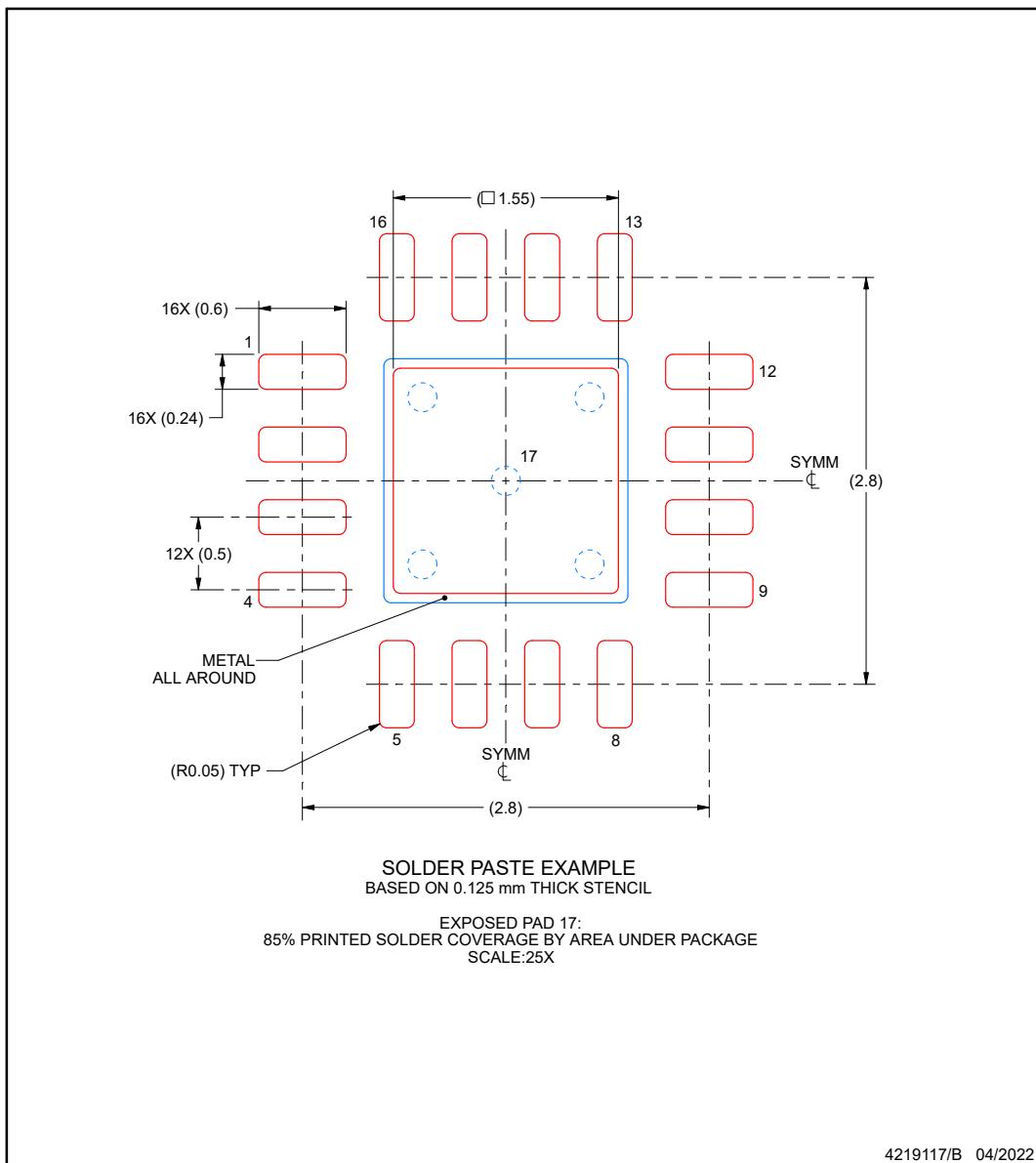
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

Product Folder Links: *LM124 LM124A LM224 LM224A LM224K LM224KA LM324 LM324A LM324B LM324BA LM324K LM324KA LM2902 LM2902B LM2902BA LM2902K LM2902KV LM2902KAV*

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EXAMPLE STENCIL DESIGN

RTE0016C

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD

(□ 1.55)

16X (0.6)

16X (0.24)

12X (0.5)

METAL
ALL AROUND

(R0.05) TYP

SYMM

SYMM

(2.8)

(2.8)

SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 17:
85% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
SCALE:25X

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NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-7704301VCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-7704301VC A LM124JQMLV	Samples
5962-9950403V9B	ACTIVE	XCEPT	KGD	0	100	RoHS & Green	Call TI	N / A for Pkg Type	-55 to 125		Samples
5962-9950403VCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9950403VC A LM124AJQMLV	Samples
77043012A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	77043012A LM124FKB	Samples
7704301CA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7704301CA LM124JB	Samples
7704301DA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7704301DA LM124WB	Samples
77043022A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	77043022A LM124AFKB	Samples
7704302CA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7704302CA LM124AJB	Samples
7704302DA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7704302DA LM124AWB	Samples
JM38510/11005BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510 /11005BCA	Samples
LM124AFKB	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	77043022A LM124AFKB	Samples
LM124AJ	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	LM124AJ	Samples
LM124AJB	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7704302CA LM124AJB	Samples
LM124AWB	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7704302DA LM124AWB	Samples
LM124D	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	-55 to 125	LM124	
LM124DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	LM124	Samples
LM124DRG4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	LM124	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM124FKB	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	77043012A LM124FKB	Samples
LM124J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	LM124J	Samples
LM124JB	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7704301CA LM124JB	Samples
LM124W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	LM124W	Samples
LM124WB	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7704301DA LM124WB	Samples
LM224AD	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	-25 to 85	LM224A	
LM224ADR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU | SN	Level-1-260C-UNLIM	-25 to 85	LM224A	Samples
LM224ADRE4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-25 to 85	LM224A	Samples
LM224ADRG4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-25 to 85	LM224A	Samples
LM224AN	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-25 to 85	LM224AN	Samples
LM224D	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	-25 to 85	LM224	
LM224DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU | SN	Level-1-260C-UNLIM	-25 to 85	LM224	Samples
LM224DRG3	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	-25 to 85	LM224	
LM224DRG4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-25 to 85	LM224	Samples
LM224KAD	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	-25 to 85	LM224KA	
LM224KADR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-25 to 85	LM224KA	Samples
LM224KADRG4	ACTIVE	SOIC	D	14	2500	TBD	Call TI	Call TI	-25 to 85		Samples
LM224KAN	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-25 to 85	LM224KAN	Samples
LM224KDR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-25 to 85	LM224K	Samples
LM224KN	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-25 to 85	LM224KN	Samples
LM224N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-25 to 85	LM224N	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM224NE4	ACTIVE	PDIP	N	14	25	TBD	Call TI	Call TI	-25 to 85		Samples
LM2902BAIDR	ACTIVE	SOIC	D	14	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2902BA	Samples
LM2902BAIPWR	ACTIVE	TSSOP	PW	14	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2902BA	Samples
LM2902BIDR	ACTIVE	SOIC	D	14	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2902B	Samples
LM2902BIPWR	ACTIVE	TSSOP	PW	14	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2902B	Samples
LM2902D	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	-40 to 125	LM2902	
LM2902DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	LM2902	Samples
LM2902DRE4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2902	Samples
LM2902DRG3	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	-40 to 125	LM2902	
LM2902DRG4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2902	Samples
LM2902KAVQDR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2902KA	Samples
LM2902KAVQDRG4	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	-40 to 125	L2902KA	
LM2902KAVQPWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2902KA	Samples
LM2902KAVQPWRG4	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2902KA	Samples
LM2902KD	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	-40 to 125	LM2902K	
LM2902KDB	ACTIVE	SSOP	DB	14	80	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2902K	Samples
LM2902KDR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2902K	Samples
LM2902KN	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-40 to 125	LM2902KN	Samples
LM2902KNSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2902K	Samples
LM2902KNSRG4	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2902K	Samples
LM2902KPW	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI	-40 to 125	L2902K	
LM2902KPWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2902K	Samples
LM2902KVQDR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2902KV	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM2902KVQDRG4	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	-40 to 125	L2902KV	
LM2902KVQPWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2902KV	Samples
LM2902KVQPWRG4	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI	-40 to 125	L2902KV	
LM2902N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU | SN	N / A for Pkg Type	-40 to 125	LM2902N	Samples
LM2902NE4	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	-40 to 125	LM2902N	
LM2902NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2902	Samples
LM2902PW	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI	-40 to 125	L2902	
LM2902PWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	L2902	Samples
LM2902PWRE4	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2902	Samples
LM2902PWRG3	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI	-40 to 125	L2902	
LM2902PWRG4	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2902	Samples
LM324AD	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	0 to 70	LM324A	
LM324ADBR	ACTIVE	SSOP	DB	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM324A	Samples
LM324ADR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU | SN	Level-1-260C-UNLIM	0 to 70	LM324A	Samples
LM324ADRG4	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	0 to 70	LM324A	
LM324AN	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	LM324AN	Samples
LM324ANSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM324A	Samples
LM324ANSRG4	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM324A	Samples
LM324APW	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI	0 to 70	L324A	
LM324APWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU | SN	Level-1-260C-UNLIM	0 to 70	L324A	Samples
LM324APWRG4	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	L324A	Samples
LM324BAIDR	ACTIVE	SOIC	D	14	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LM324BA	Samples
LM324BAIPWR	ACTIVE	TSSOP	PW	14	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	L324BA	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM324BIDR	ACTIVE	SOIC	D	14	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LM324B	Samples
LM324BIPWR	ACTIVE	TSSOP	PW	14	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LM324B	Samples
LM324D	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	0 to 70	LM324	
LM324DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	SN	Level-1-260C-UNLIM	0 to 70	LM324	Samples
LM324DRE4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM324	Samples
LM324DRG3	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	0 to 70	LM324	
LM324DRG4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM324	Samples
LM324KAD	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	0 to 70	LM324KA	
LM324KADR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM324KA	Samples
LM324KADRG4	ACTIVE	SOIC	D	14	2500	TBD	Call TI	Call TI	0 to 70		Samples
LM324KAN	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	LM324KAN	Samples
LM324KANSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM324KA	Samples
LM324KAPW	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI	0 to 70	L324KA	
LM324KAPWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	L324KA	Samples
LM324KDR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM324K	Samples
LM324KN	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	LM324KN	Samples
LM324KNSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM324K	Samples
LM324KPW	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI	0 to 70	L324K	
LM324KPWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	L324K	Samples
LM324N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	SN	N / A for Pkg Type	0 to 70	LM324N	Samples
LM324NE3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	0 to 70	LM324N	
LM324NE4	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	0 to 70	LM324N	
LM324NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM324	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM324NSRE4	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM324	Samples
LM324NSRG4	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM324	Samples
LM324PW	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI	0 to 70	L324	
LM324PWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU | SN	Level-1-260C-UNLIM	0 to 70	L324	Samples
LM324PWRE4	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	L324	Samples
LM324PWRG3	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI	0 to 70	L324	
LM324PWRG4	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	L324	Samples
M38510/11005BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510 /11005BCA	Samples
PLM2902BIDR	ACTIVE	SOIC	D	14	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PLM324BIDR	ACTIVE	SOIC	D	14	3000	TBD	Call TI	Call TI	-40 to 85		Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF LM124, LM124-SP, LM124M, LM2902, LM2902B, LM2902BA :

- Catalog : LM124, LM124

- Automotive : LM2902-Q1, LM2902B-Q1, LM2902BA-Q1

- Enhanced Product : LM2902-EP

- Military : LM124M, LM124M

- Space : LM124-SP, LM124-SP

NOTE: Qualified Version Definitions:
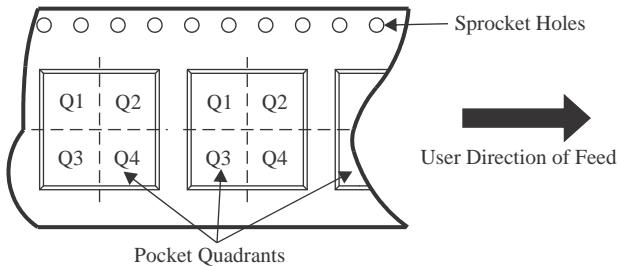
- Catalog - TI's standard catalog product

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

- Enhanced Product - Supports Defense, Aerospace and Medical Applications

- Military - QML certified for Military and Defense Applications

- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers
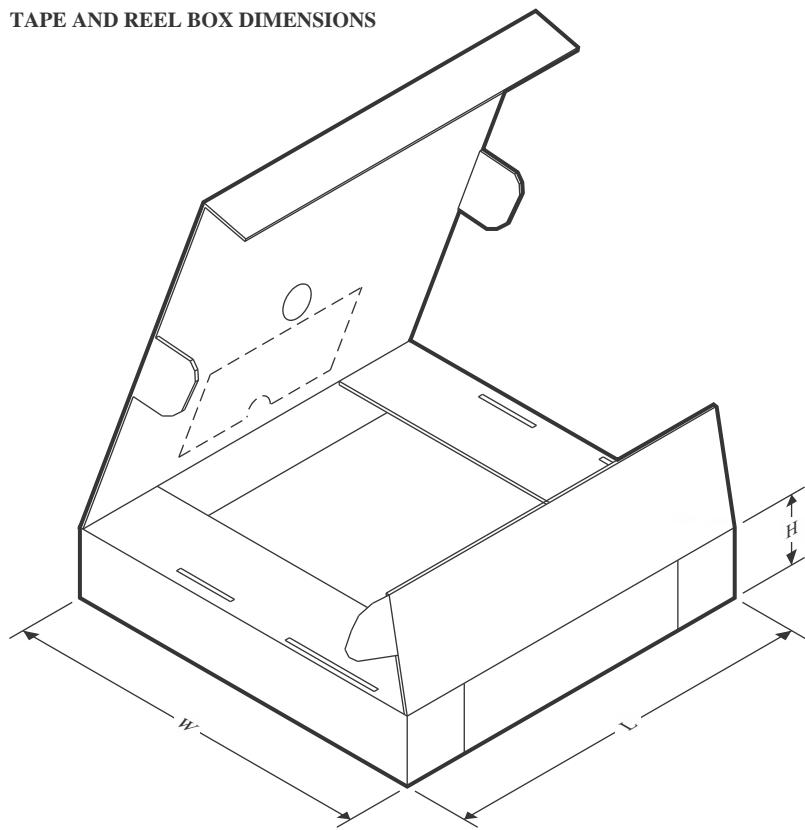
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

*All dimensions are nominal

| Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM124DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM224ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM224ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM224ADRG4	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM224ADRG4	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM224DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM224DRG4	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM224KADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM224KDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM2902BAIDR	SOIC	D	14	3000	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2902BAIPWR	TSSOP	PW	14	3000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2902BIDR	SOIC	D	14	3000	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2902DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM2902DRG4	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM2902KAVQPWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2902KAVQPWRG4	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2902KDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM2902KNSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
LM2902KPWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2902KVQPWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2902NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
LM2902PWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2902PWRG4	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM324ADBR	SSOP	DB	14	2000	330.0	16.4	8.35	6.6	2.4	12.0	16.0	Q1
LM324ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM324ANSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
LM324APWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM324APWRG4	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM324BAIDR	SOIC	D	14	3000	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM324BAIPWR	TSSOP	PW	14	3000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM324BIDR	SOIC	D	14	3000	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM324BIPWR	TSSOP	PW	14	3000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM324DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM324DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM324DRG4	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM324DRG4	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM324KADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM324KANSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
LM324KAPWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM324KDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM324KNSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
LM324KPWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM324NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
LM324PWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM324PWRG4	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
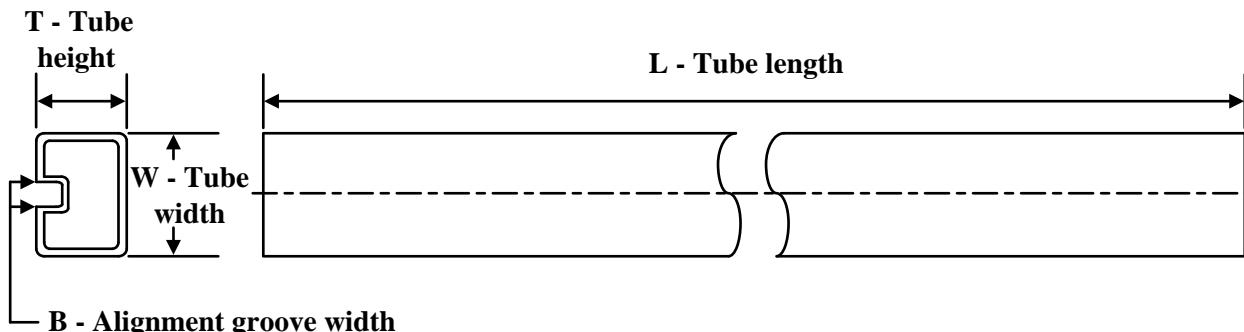
TAPE AND REEL BOX DIMENSIONS

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM124DR	SOIC	D	14	2500	350.0	350.0	43.0
LM224ADR	SOIC	D	14	2500	340.5	336.1	32.0
LM224ADR	SOIC	D	14	2500	356.0	356.0	35.0
LM224ADRG4	SOIC	D	14	2500	340.5	336.1	32.0
LM224ADRG4	SOIC	D	14	2500	356.0	356.0	35.0
LM224DR	SOIC	D	14	2500	356.0	356.0	35.0
LM224DRG4	SOIC	D	14	2500	356.0	356.0	35.0
LM224KADR	SOIC	D	14	2500	356.0	356.0	35.0
LM224KDR	SOIC	D	14	2500	356.0	356.0	35.0
LM2902BAIDR	SOIC	D	14	3000	353.0	353.0	32.0
LM2902BAIPWR	TSSOP	PW	14	3000	356.0	356.0	35.0
LM2902BIDR	SOIC	D	14	3000	340.5	336.1	25.0
LM2902DR	SOIC	D	14	2500	353.0	353.0	32.0
LM2902DRG4	SOIC	D	14	2500	353.0	353.0	32.0
LM2902KAVQPWR	TSSOP	PW	14	2000	356.0	356.0	35.0
LM2902KAVQPWRG4	TSSOP	PW	14	2000	367.0	367.0	35.0
LM2902KDR	SOIC	D	14	2500	356.0	356.0	35.0
LM2902KNSR	SO	NS	14	2000	356.0	356.0	35.0

PACKAGE MATERIALS INFORMATION

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2902KPWR	TSSOP	PW	14	2000	356.0	356.0	35.0
LM2902KVQPWR	TSSOP	PW	14	2000	356.0	356.0	35.0
LM2902NSR	SO	NS	14	2000	356.0	356.0	35.0
LM2902PWR	TSSOP	PW	14	2000	356.0	356.0	35.0
LM2902PWRG4	TSSOP	PW	14	2000	356.0	356.0	35.0
LM324ADBR	SSOP	DB	14	2000	356.0	356.0	35.0
LM324ADR	SOIC	D	14	2500	356.0	356.0	35.0
LM324ANSR	SO	NS	14	2000	356.0	356.0	35.0
LM324APWR	TSSOP	PW	14	2000	356.0	356.0	35.0
LM324APWRG4	TSSOP	PW	14	2000	356.0	356.0	35.0
LM324BAIDR	SOIC	D	14	3000	340.5	336.1	25.0
LM324BAIPWR	TSSOP	PW	14	3000	356.0	356.0	35.0
LM324BIDR	SOIC	D	14	3000	340.5	336.1	25.0
LM324BIPWR	TSSOP	PW	14	3000	356.0	356.0	35.0
LM324DR	SOIC	D	14	2500	353.0	353.0	32.0
LM324DR	SOIC	D	14	2500	356.0	356.0	35.0
LM324DRG4	SOIC	D	14	2500	353.0	353.0	32.0
LM324DRG4	SOIC	D	14	2500	356.0	356.0	35.0
LM324KADR	SOIC	D	14	2500	356.0	356.0	35.0
LM324KANSR	SO	NS	14	2000	356.0	356.0	35.0
LM324KAPWR	TSSOP	PW	14	2000	356.0	356.0	35.0
LM324KDR	SOIC	D	14	2500	356.0	356.0	35.0
LM324KNSR	SO	NS	14	2000	356.0	356.0	35.0
LM324KPWR	TSSOP	PW	14	2000	356.0	356.0	35.0
LM324NSR	SO	NS	14	2000	356.0	356.0	35.0
LM324PWR	TSSOP	PW	14	2000	356.0	356.0	35.0
LM324PWRG4	TSSOP	PW	14	2000	356.0	356.0	35.0

TUBE

T - Tube height

L - Tube length

W - Tube width

B - Alignment groove width

*All dimensions are nominal
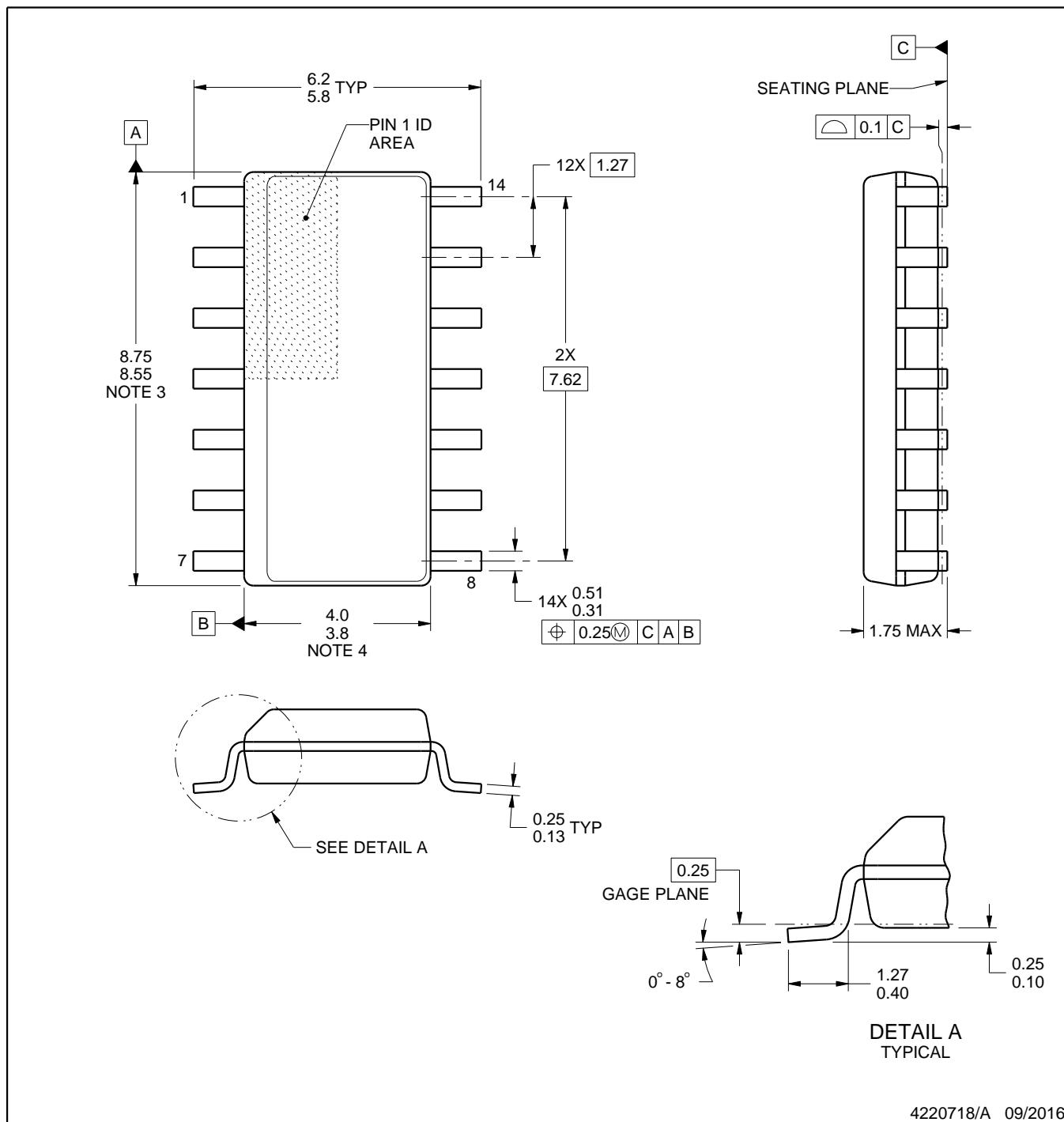
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-9950403VCA	J	CDIP	14	25	506.98	15.24	13440	NA
77043012A	FK	LCCC	20	55	506.98	12.06	2030	NA
7704301DA	W	CFP	14	25	506.98	26.16	6220	NA
77043022A	FK	LCCC	20	55	506.98	12.06	2030	NA
7704302DA	W	CFP	14	25	506.98	26.16	6220	NA
LM124AFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
LM124AWB	W	CFP	14	25	506.98	26.16	6220	NA
LM124FKB	FK	LCCC	20	55	506.98	12.06	2030	NA
LM124W	W	CFP	14	25	506.98	26.16	6220	NA
LM124WB	W	CFP	14	25	506.98	26.16	6220	NA
LM224AN	N	PDIP	14	25	506	13.97	11230	4.32
LM224KAN	N	PDIP	14	25	506	13.97	11230	4.32
LM224KN	N	PDIP	14	25	506	13.97	11230	4.32
LM224N	N	PDIP	14	25	506	13.97	11230	4.32
LM2902KDB	DB	SSOP	14	80	530	10.5	4000	4.1
LM2902KN	N	PDIP	14	25	506	13.97	11230	4.32
LM2902N	N	PDIP	14	25	506	13.97	11230	4.32
LM2902N	N	PDIP	14	25	506.1	9	600	5.4
LM324AN	N	PDIP	14	25	506	13.97	11230	4.32
LM324AN	N	PDIP	14	25	506	13.97	11230	4.32
LM324KAN	N	PDIP	14	25	506	13.97	11230	4.32
LM324KAN	N	PDIP	14	25	506	13.97	11230	4.32
LM324KN	N	PDIP	14	25	506	13.97	11230	4.32
LM324KN	N	PDIP	14	25	506	13.97	11230	4.32
LM324N	N	PDIP	14	25	506	13.97	11230	4.32
LM324N	N	PDIP	14	25	506	13.97	11230	4.32
LM324N	N	PDIP	14	25	506	13.97	11230	4.32
LM324N	N	PDIP	14	25	506.1	9	600	5.4

6.2
5.8 TYP

A

PIN 1 ID
AREA

1

14

12X 1.27

8.75
8.55
NOTE 3

2X
7.62

7

8

14X 0.51
0.31

B

4.0
3.8
NOTE 4

⊕ 0.25Ⓜ C A B

C

SEATING PLANE

⌒ 0.1 C

1.75 MAX

SEE DETAIL A

0.25
0.13 TYP

0.25
GAGE PLANE

0°- 8°

1.27
0.40

0.25
0.10

DETAIL A
TYPICAL

4220718/A   09/2016

NOTES:
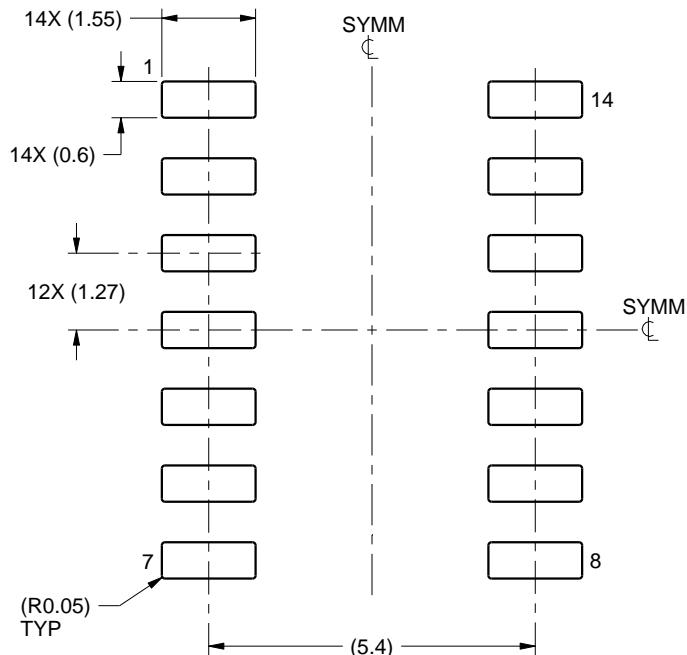
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
   per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
   exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.
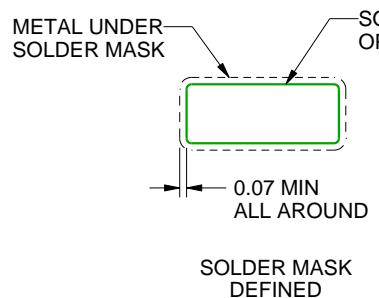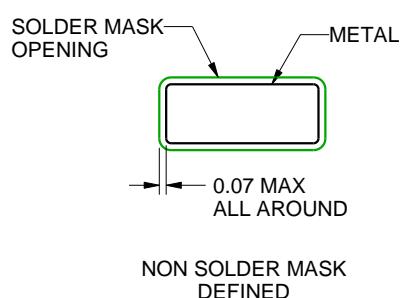
LAND PATTERN EXAMPLE
SCALE:8X

SOLDER MASK DETAILS

4220718/A   09/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
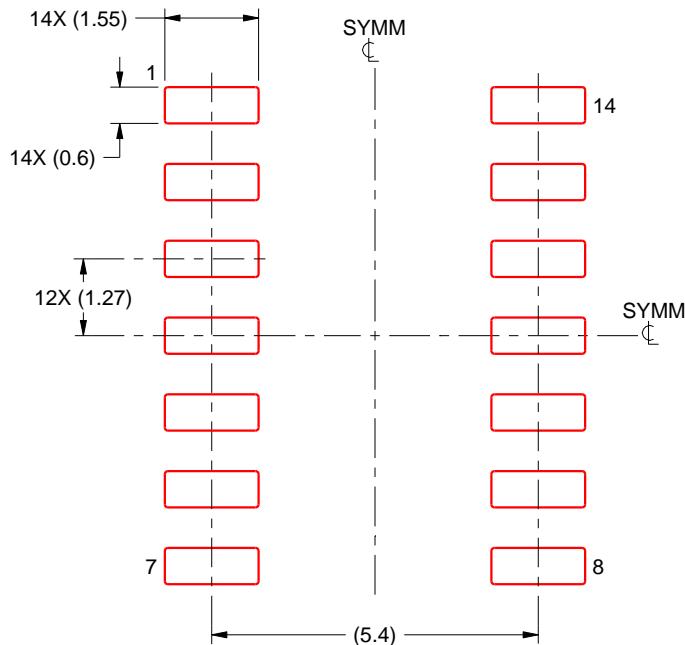
14X (1.55)

SYMM
₵

1

14X (0.6)

14

12X (1.27)

SYMM
₵

7

8

(5.4)

SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:8X

4220718/A   09/2016

NOTES: (continued)
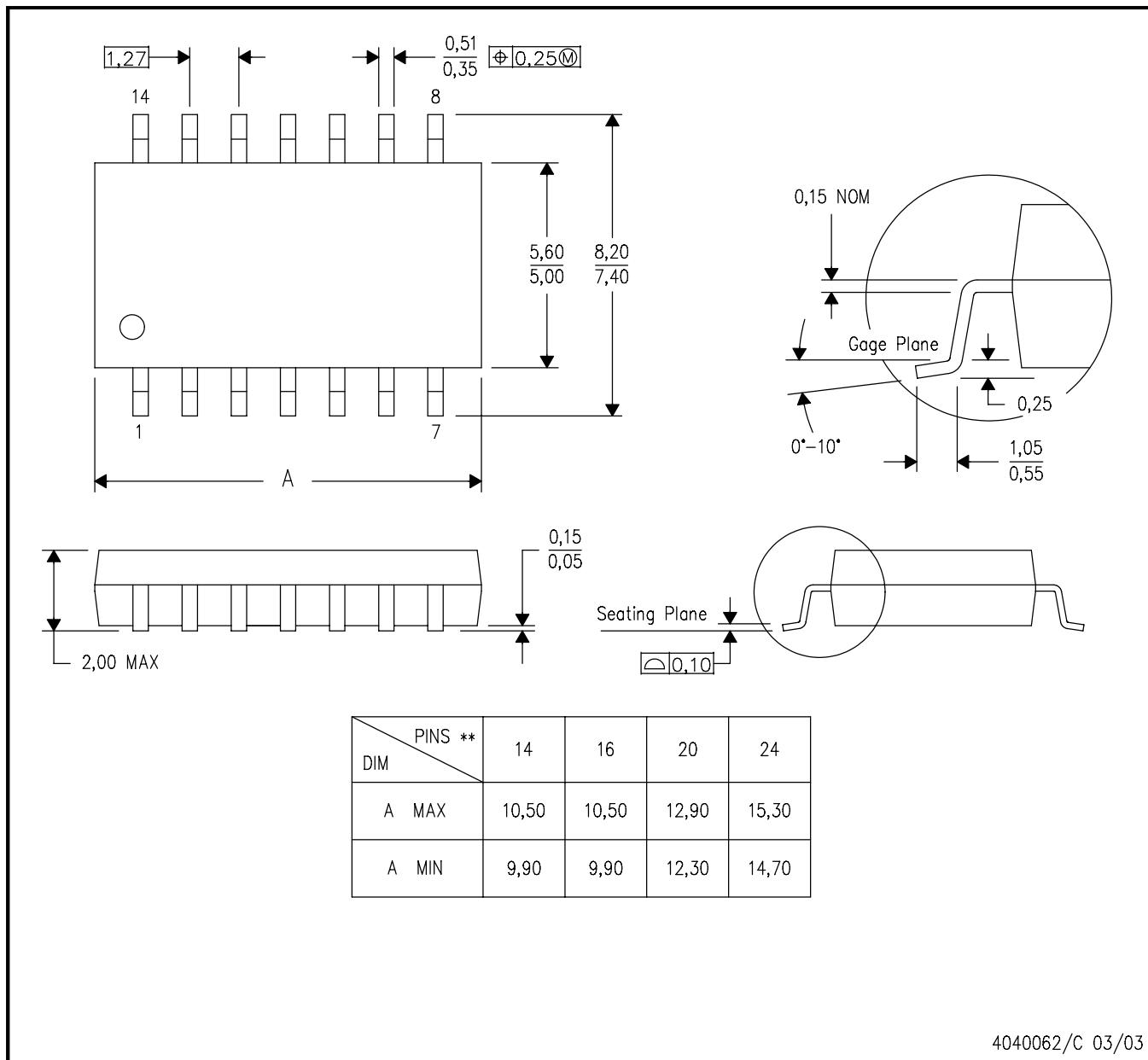
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

MECHANICAL DATA

NS (R-PDSO-G**)   **PLASTIC SMALL-OUTLINE PACKAGE**

14-PINS SHOWN

1,27

0,51 / 0,35

⊕ 0,25 Ⓜ

14

8

1

7

5,60 / 5,00

8,20 / 7,40

A

0,15 NOM

Gage Plane

0,25

0°–10°

1,05 / 0,55

0,15 / 0,05

2,00 MAX

Seating Plane

0,10

DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03
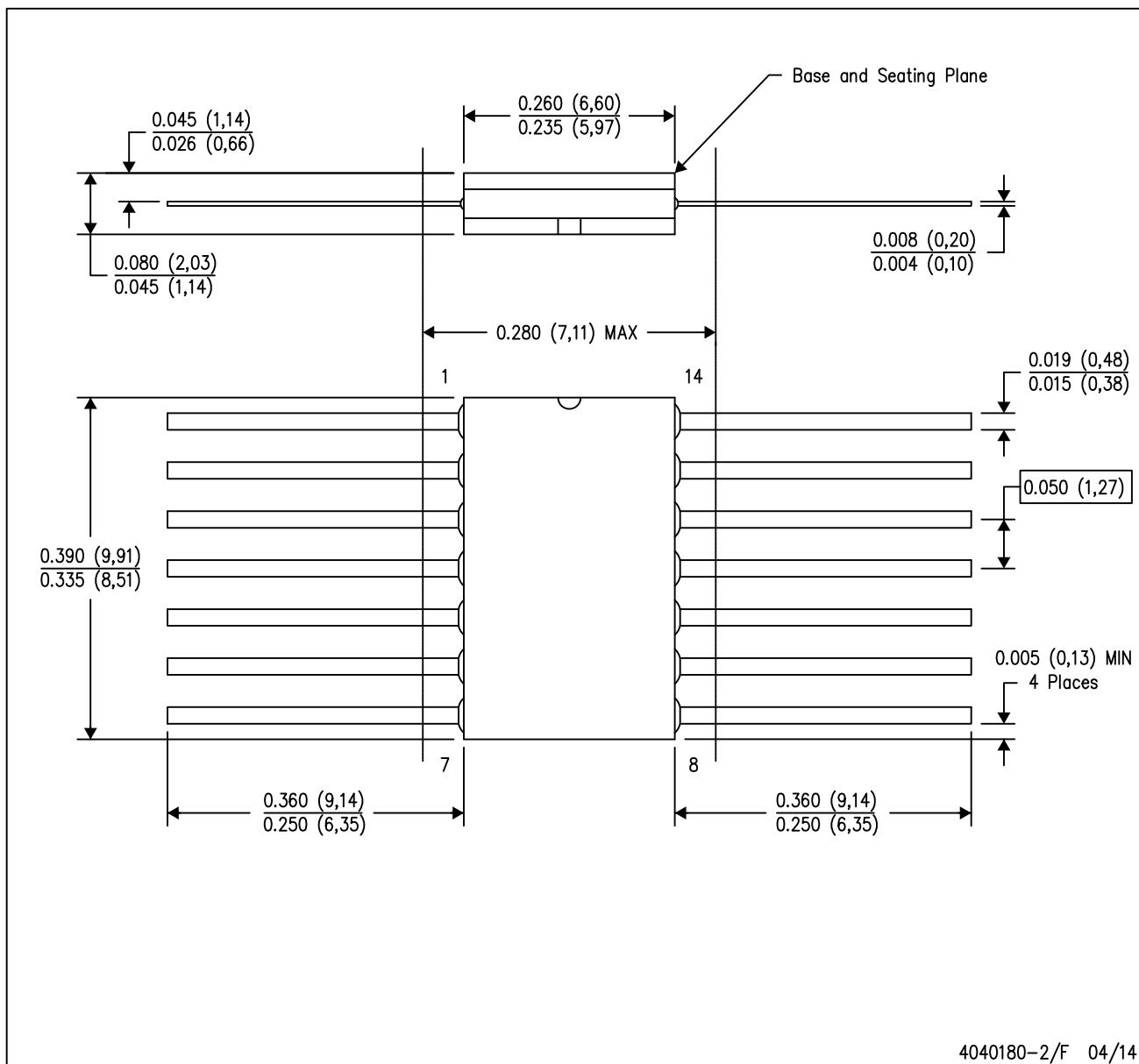
NOTES: A. All linear dimensions are in millimeters.
             B. This drawing is subject to change without notice.
   C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

TEXAS INSTRUMENTS

www.ti.com

W (R−GDFP−F14)   CERAMIC DUAL FLATPACK
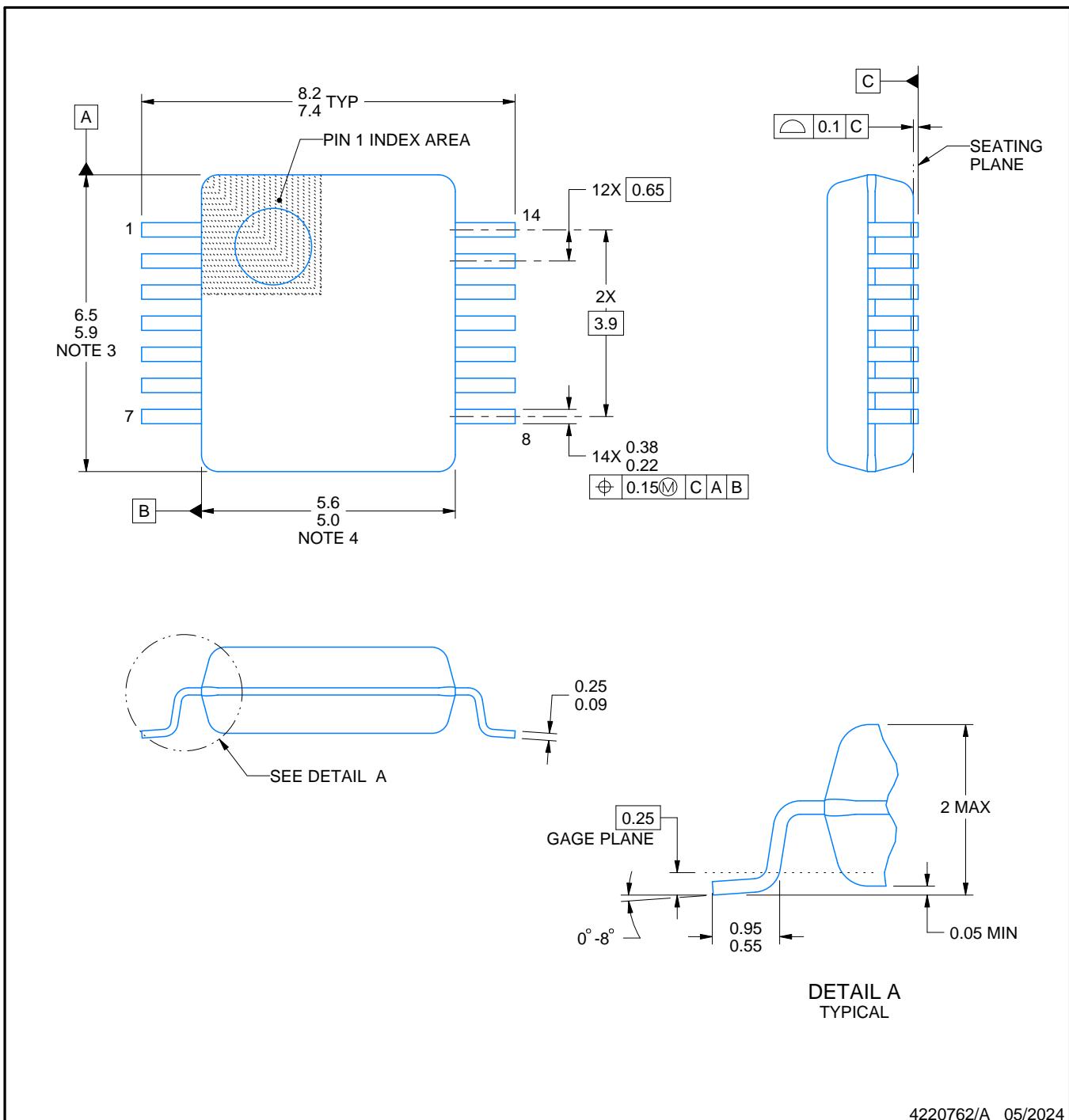
Base and Seating Plane

$\dfrac{0.260\ (6,60)}{0.235\ (5,97)}$

$\dfrac{0.045\ (1,14)}{0.026\ (0,66)}$

$\dfrac{0.008\ (0,20)}{0.004\ (0,10)}$

$\dfrac{0.080\ (2,03)}{0.045\ (1,14)}$

0.280 (7,11) MAX

1   14

$\dfrac{0.019\ (0,48)}{0.015\ (0,38)}$

$\dfrac{0.390\ (9,91)}{0.335\ (8,51)}$

0.050 (1,27)

0.005 (0,13) MIN
4 Places

7   8

$\dfrac{0.360\ (9,14)}{0.250\ (6,35)}$ $\dfrac{0.360\ (9,14)}{0.250\ (6,35)}$

4040180−2/F 04/14

NOTES: A. All linear dimensions are in inches (millimeters).
        B. This drawing is subject to change without notice.
        C. This package can be hermetically sealed with a ceramic lid using glass frit.
        D. Index point is provided on cap for terminal identification only.
   E. Falls within MIL STD 1835 GDFP1−F14
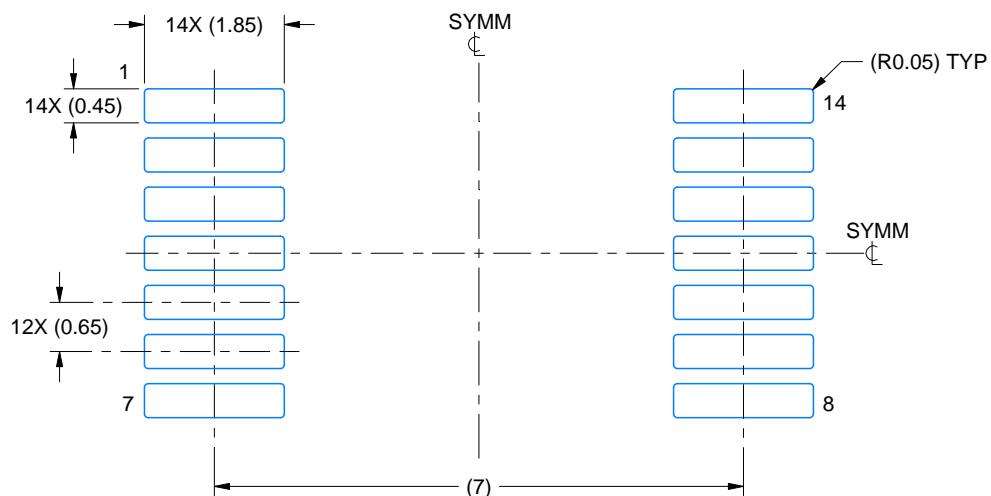
TEXAS INSTRUMENTS
www.ti.com

DB0014A

8.2 / 7.4 TYP

A

PIN 1 INDEX AREA

1

6.5 / 5.9 NOTE 3

7

B

5.6 / 5.0 NOTE 4

12X 0.65

14

2X 3.9

8

14X 0.38 / 0.22

⊕ 0.15 Ⓜ C A B

C

⌒ 0.1 C

SEATING PLANE

0.25 / 0.09

SEE DETAIL A

GAGE PLANE

0.25

2 MAX

0°-8°

0.95 / 0.55

0.05 MIN

DETAIL A
TYPICAL

4220762/A   05/2024

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-150.

14X (1.85)

14X (0.45)

1

12X (0.65)

7

SYMM

(R0.05) TYP

14

SYMM

8

(7)

LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X

SOLDER MASK
OPENING

METAL

EXPOSED METAL

0.05 MAX
ALL AROUND

NON-SOLDER MASK
DEFINED
(PREFERRED)

METAL UNDER
SOLDER MASK

SOLDER MASK
OPENING

EXPOSED METAL

0.05 MIN
ALL AROUND

SOLDER MASK
DEFINED

SOLDER MASK DETAILS

4220762/A   05/2024

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

14X (1.85)

SYMM

1

14X (0.45)

(R0.05) TYP

14

SYMM

12X (0.65)

7

8

(7)

SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 10X

4220762/A   05/2024
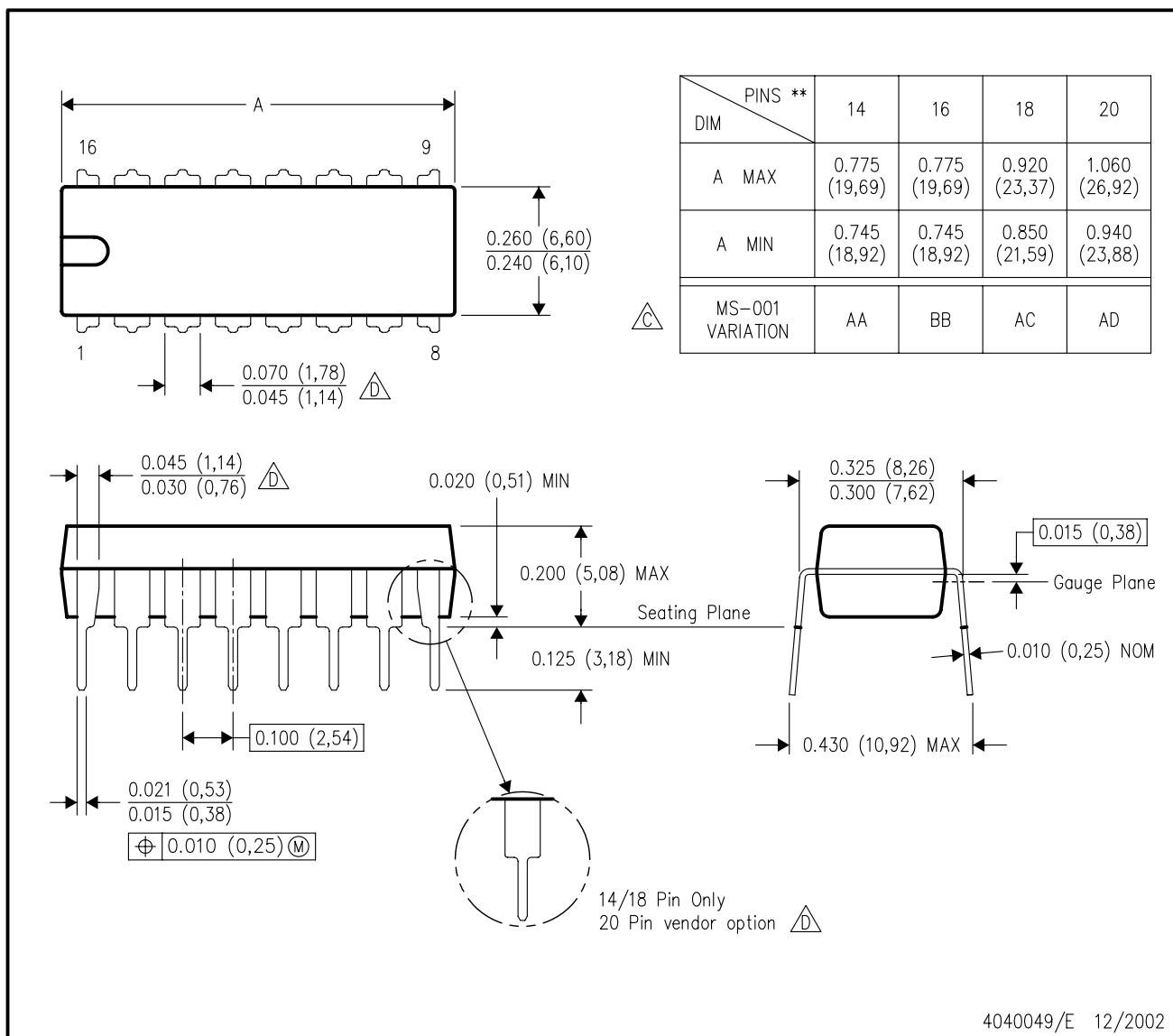
NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

N (R−PDIP−T**)
16 PINS SHOWN

PLASTIC DUAL−IN−LINE PACKAGE
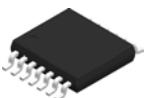
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS−001 VARIATION	AA	BB	AC	AD

0.260 (6,60) / 0.240 (6,10)

0.070 (1,78) / 0.045 (1,14) ⬠D

0.045 (1,14) / 0.030 (0,76) ⬠D

0.020 (0,51) MIN

0.200 (5,08) MAX

Seating Plane

0.125 (3,18) MIN

0.100 (2,54)

0.021 (0,53) / 0.015 (0,38)

⊕ 0.010 (0,25) Ⓜ

14/18 Pin Only
20 Pin vendor option ⬠D

0.325 (8,26) / 0.300 (7,62)

0.015 (0,38)

Gauge Plane

0.010 (0,25) NOM

0.430 (10,92) MAX

4040049/E   12/2002

NOTES: A.   All linear dimensions are in inches (millimeters).
B.   This drawing is subject to change without notice.
⬠C   Falls within JEDEC MS−001, except 18 and 20 pin minimum body length (Dim A).
⬠D   The 20 pin end lead shoulder width is a vendor option, either half or full width.

TEXAS
INSTRUMENTS
www.ti.com

A

6.6
6.2 TYP

PIN 1 INDEX AREA

1

14

12X 0.65

2X
3.9

5.1
4.9
NOTE 3

7

8

14X 0.30
0.17

⊕ 0.1 Ⓜ C A B

B

4.5
4.3
NOTE 4

SEATING
PLANE

C

�', 0.1 C

4X (0°-12°)

1.2 MAX

SEE DETAIL A

(0.15) TYP

0.25
GAGE PLANE

0.15
0.05

0°-8°

0.75
0.50

DETAIL A
TYPICAL

4220202/B   12/2023

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.
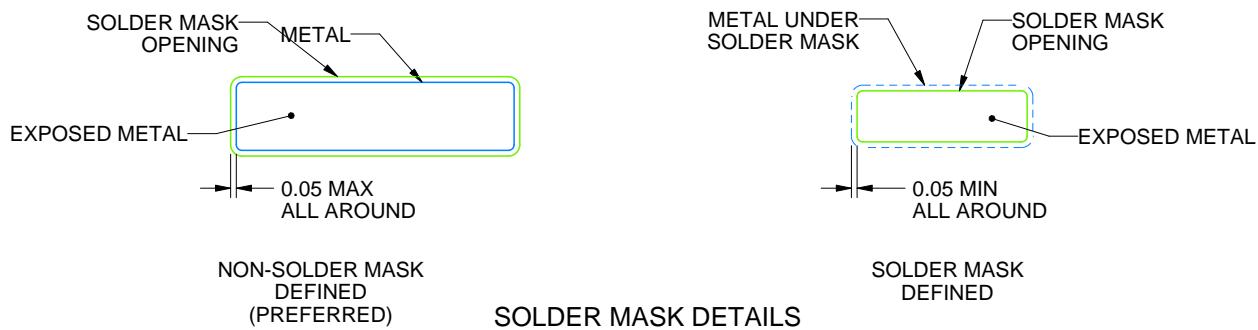
PW0014A

TSSOP - 1.2 mm max height

14X (1.5)

SYMM

1

(R0.05) TYP

14X (0.45)

14

SYMM

12X (0.65)

7

8

(5.8)

LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X

SOLDER MASK
OPENING

METAL

METAL UNDER
SOLDER MASK

SOLDER MASK
OPENING

EXPOSED METAL

EXPOSED METAL

0.05 MAX
ALL AROUND

0.05 MIN
ALL AROUND

NON-SOLDER MASK
DEFINED
(PREFERRED)

SOLDER MASK DETAILS

SOLDER MASK
DEFINED

4220202/B   12/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

14X (1.5)

SYMM

1

14X (0.45)

(R0.05) TYP

14

SYMM

12X (0.65)

7

8

(5.8)

SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 10X

4220202/B   12/2023

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.
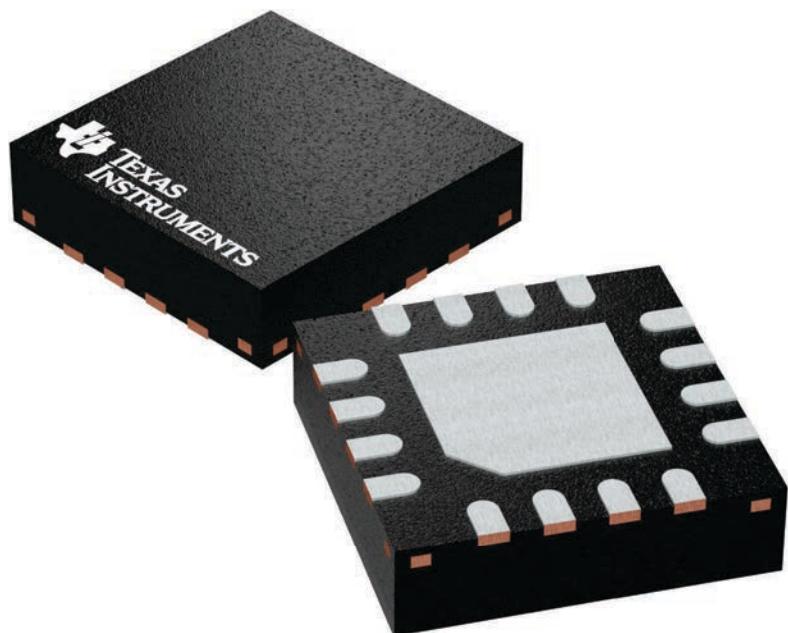
RTE 16

**3 x 3, 0.5 mm pitch**

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4225944/A
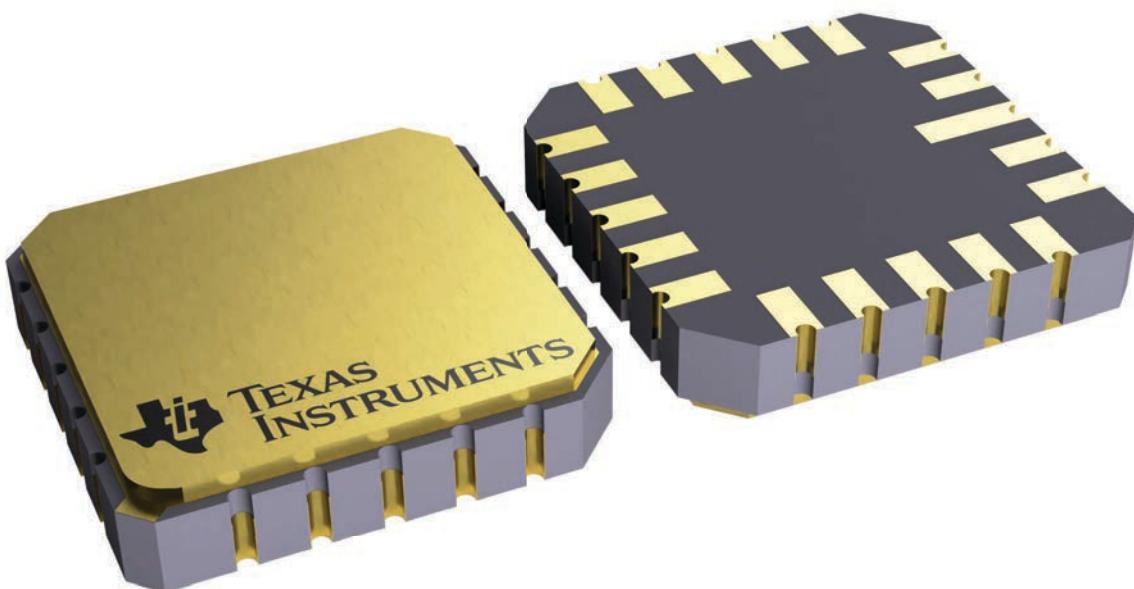
FK 20

8.89 x 8.89, 1.27 mm pitch

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.
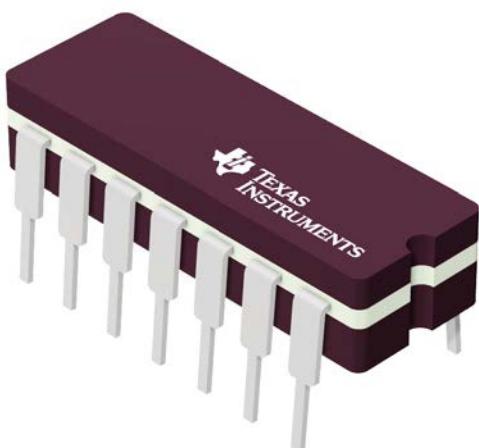
4229370VA\
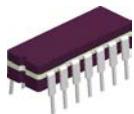
Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4040083-5/G
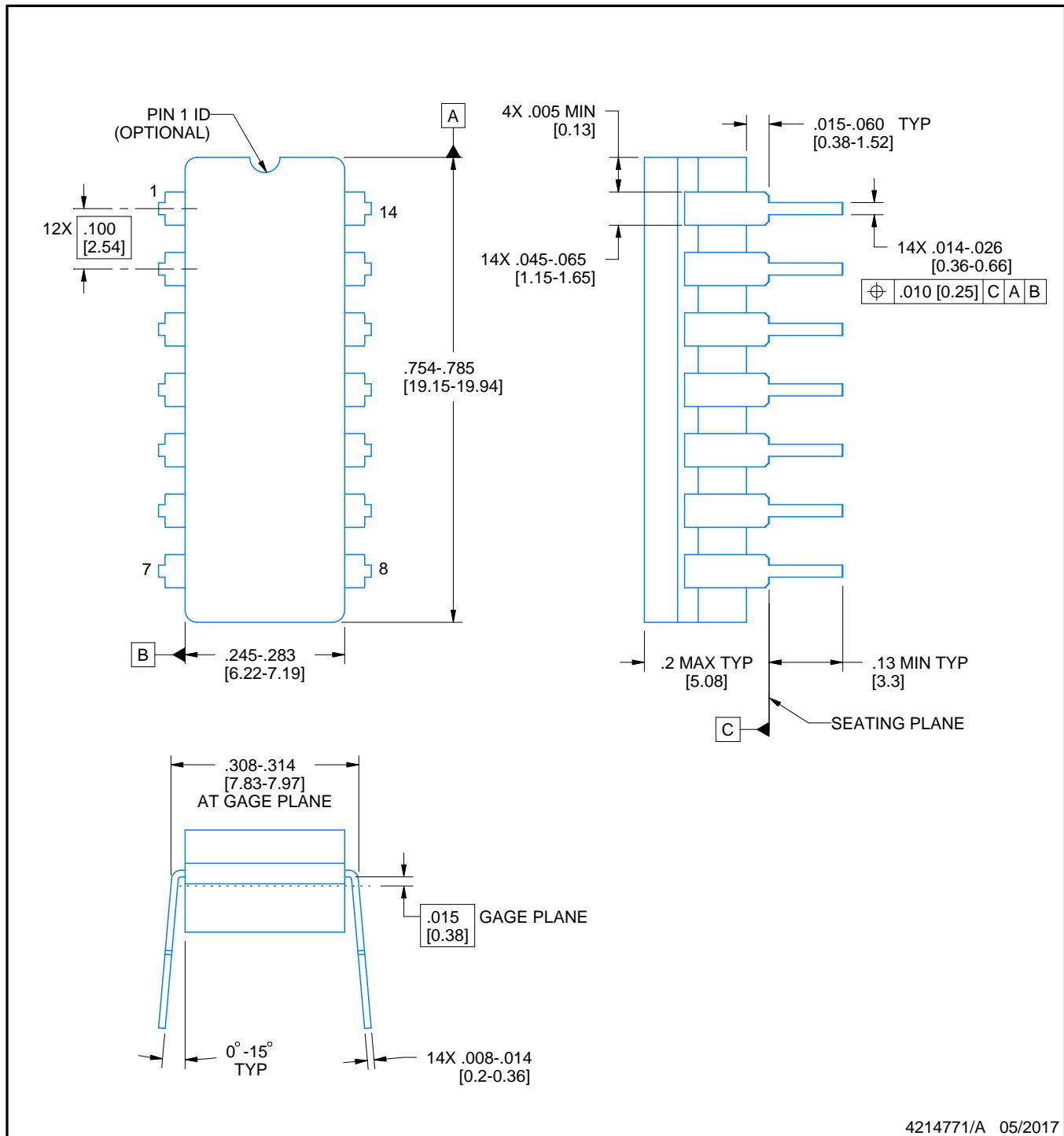
TEXAS
INSTRUMENTS

PIN 1 ID
(OPTIONAL)

[A]

1

14

12X .100
[2.54]

7

8

.754-.785
[19.15-19.94]

[B]

.245-.283
[6.22-7.19]

4X .005 MIN
[0.13]

14X .045-.065
[1.15-1.65]

.015-.060 TYP
[0.38-1.52]

14X .014-.026
[0.36-0.66]

⊕ .010 [0.25] C A B

.2 MAX TYP
[5.08]

.13 MIN TYP
[3.3]

[C]

SEATING PLANE

.308-.314
[7.83-7.97]
AT GAGE PLANE

.015
[0.38]

GAGE PLANE

0°-15°
TYP

14X .008-.014
[0.2-0.36]

4214771/A 05/2017

NOTES:
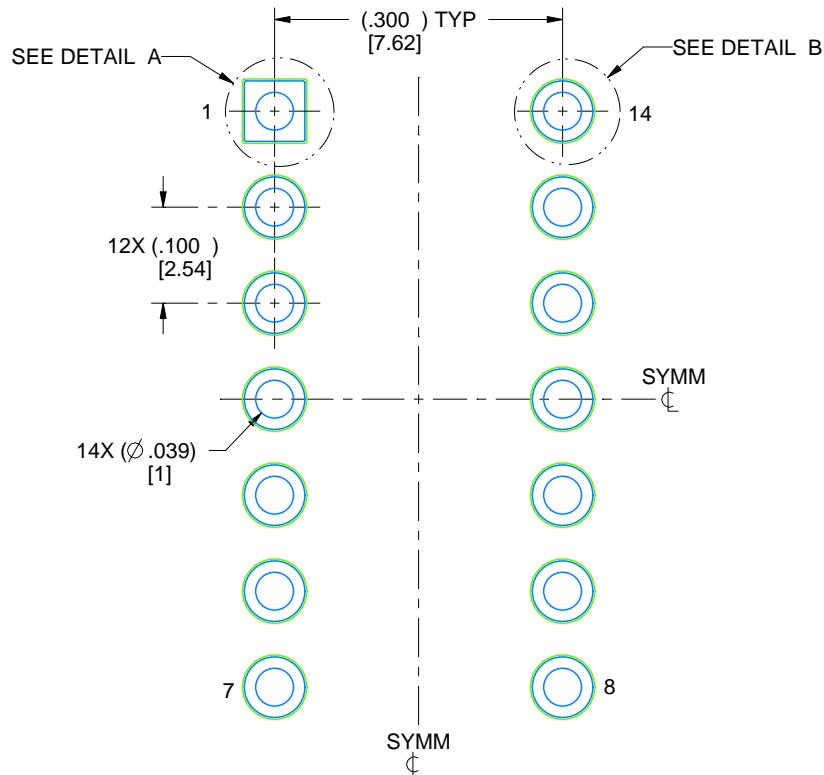
1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package is hermitically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
5. Falls within MIL-STD-1835 and GDIP1-T14.

(.300) TYP
[7.62]

SEE DETAIL A

SEE DETAIL B

1

14

12X (.100)
[2.54]

SYMM
₵

14X (∅ .039)
[1]

7

8

SYMM
₵
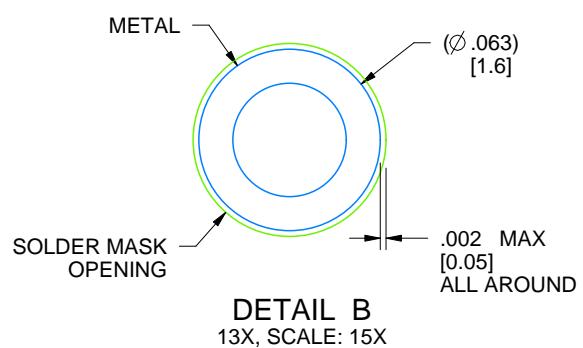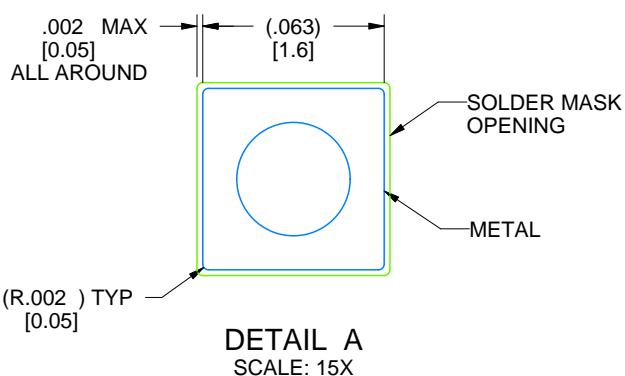
LAND PATTERN EXAMPLE
NON-SOLDER MASK DEFINED
SCALE: 5X

.002 MAX
[0.05]
ALL AROUND

(.063)
[1.6]

SOLDER MASK
OPENING

METAL

(R.002) TYP
[0.05]

DETAIL A
SCALE: 15X

METAL

(∅ .063)
[1.6]

SOLDER MASK
OPENING

.002 MAX
[0.05]
ALL AROUND

DETAIL B
13X, SCALE: 15X

4214771/A   05/2017

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